DT302

FIELDBUS CONCENTRATION DENSITY TRANSMITTER

MAY / 16

DT302

VERSION 3









Specifications and information are subject to change without notice.

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INTRODUCTION

The **DT302** is from the first generation of Fieldbus Foundation devices. It is a transmitter for concentration and density measurements. It is based on a field-proven capacitive sensor that provides reliable operation and high performance. The digital technology used in the **DT302** enables the choice of several types of transfer functions, an easy interface between the field and the control room and several interesting features that considerably reduce the installation, operation and maintenance costs.

The Concentration/Density transmitter **DT302 (Touché)** is a device to measure in continuous mode the concentration and density of liquids, directly in industrial process.

The **DT302** is composed for a probe with two repeater diaphragms into the process fluid. The probe is connected to a capacitive sensor, extern to the process, through the capillaries. A fill fluid transmits the process pressure in the two repeater diaphragms to the differential pressure sensor.

A temperature sensor into the probe and between the two repeater diaphragms makes the automatic compensation of any temperature variation of the process. The factory procedure of the probe and temperature sensor allow that small process temperature variations be fast informed to the transmitter, that using a specific software calculates with precision the value of density in the process.

According to the industrial process, the measured concentration by means **DT302** can be expressed in Density, Relative Density, Brix Degree, Baumé Degree, INPM Degree, Plato Degree, Solid %, etc.

The **DT302** is part of Smar's complete 302 line of Fieldbus Foundation devices.

Some of the advantages of bi-directional digital communications are known from existing smart transmitter protocols: Higher accuracy, multi-variable access, remote configuration and diagnostics, and multi-dropping of several devices on a single pair of wires.

The system controls variable sampling, algorithm execution and communication so as to optimize the usage of the network, not loosing time. Thus, high closed loop performance is achieved. Using Fieldbus technology, with its capability to interconnect several devices, very large control schemes can be constructed. In order too be user friendly the function block concept was introduced

The **DT302**, like the rest of the 302 family, has some Function Blocks built in, like Analog Input Block.

The need for implementation of Fieldbus in small as well as large systems was considered when developing the entire 302 line of Fieldbus Foundation devices.

They have common features and can be configured locally using a magnetic tool, eliminating the need for a configurator or console in many basic applications.

The **DT302** is available as a product on its own, but also replaces the circuit board for the DT301. They use the same sensor board. Refer to the maintenance section of this manual for instructions on upgrading. The **DT302** uses the same hardware and housing for the **DT302**.

The **DT302**, like its predecessor DT301, has some built-in blocks, eliminating the need for a separate control device. The communication requirement is considerably reduced, and that means less dead-time and tighter control is achieved, not to mention the reduction in cost. They allow flexibility in control strategy implementation.

ATTENTION

Get the best results of the DT302 by carefully reading these instructions.

This product is protected by US patent numbers: 6,234,019; D439,855 and 5,827,963.

NOTE

This Manual is compatible with version 3.XX, where 3 denotes software version and XX software release. The indication 3.XX means that this manual is compatible with any release of software version 3.

Waiver of responsibility

The contents of this manual abides by the hardware and software used on the current equipment version. Eventually there may occur divergencies between this manual and the equipment. The information from this document are periodically reviewed and the necessary or identified corrections will be included in the following editions. Suggestions for their improvement are welcome.

Warning

For more objectivity and clarity, this manual does not contain all the detailed information on the product and, in addition, it does not cover every possible mounting, operation or maintenance cases.

Before installing and utilizing the equipment, check if the model of the acquired equipment complies with the technical requirements for the application. This checking is the user's responsibility.

If the user needs more information, or on the event of specific problems not specified or treated in this manual, the information should be sought from Smar. Furthermore, the user recognizes that the contents of this manual by no means modify past or present agreements, confirmation or judicial relationship, in whole or in part.

All of Smar's obligation result from the purchasing agreement signed between the parties, which includes the complete and sole valid warranty term. Contractual clauses related to the warranty are not limited nor extended by virtue of the technical information contained in this manual.

Only qualified personnel are allowed to participate in the activities of mounting, electrical connection, startup and maintenance of the equipment. Qualified personnel are understood to be the persons familiar with the mounting, electrical connection, startup and operation of the equipment or other similar apparatus that are technically fit for their work. Smar provides specific training to instruct and qualify such professionals. However, each country must comply with the local safety procedures, legal provisions and regulations for the mounting and operation of electrical installations, as well as with the laws and regulations on classified areas, such as intrinsic safety, explosion proof, increased safety and instrumented safety systems, among others.

The user is responsible for the incorrect or inadequate handling of equipments run with pneumatic or hydraulic pressure or, still, subject to corrosive, aggressive or combustible products, since their utilization may cause severe bodily harm and/or material damages.

The field equipment referred to in this manual, when acquired for classified or hazardous areas, has its certification void when having its parts replaced or interchanged without functional and approval tests by Smar or any of Smar authorized dealers, which are the competent companies for certifying that the equipment in its entirety meets the applicable standards and regulations. The same is true when converting the equipment of a communication protocol to another. In this case, it is necessary sending the equipment to Smar or any of its authorized dealer. Moreover, the certificates are different and the user is responsible for their correct use.

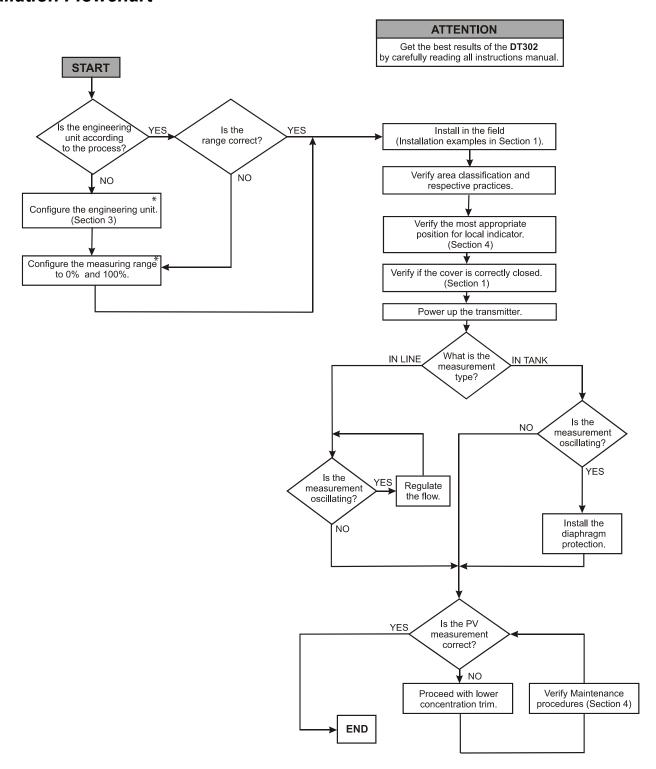
Always respect the instructions provided in the Manual. Smar is not responsible for any losses and/or damages resulting from the inadequate use of its equipments. It is the user's responsibility to know and apply the safety practices in his country.

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Installation Flowchart



 $^{^{\}star}$ More information in Section 3 from DT302 Operation, Maintenance and Instructions Manual.

^{**} Tip: The Brix of water is 0 (zero)/ or H_2O density = 998.2@20 $^{\circ}$ C.

INSTALLATION

The overall accuracy of a density measurement depends on several variables. Although the transmitter has an outstanding performance, proper installation is essential to maximize its performance.

Among all factors, which may affect transmitter accuracy, environmental conditions are the most difficult to control. There are, however, ways of reducing the effects of temperature, humidity and vibration.

General

The **DT302** has a built-in temperature sensor to compensate for temperature variations. At the factory, each transmitter is submitted to a temperature cycle process, and the characteristics under different pressures and temperatures are recorded in the transmitter memory. At the field, this feature minimizes the temperature variation effect.

Locating the transmitter in areas protected from extreme environmental changes can minimize temperature fluctuation effects.

The transmitter should be installed in such a way as to avoid, as much as possible, direct exposure to the sun or any source of irradiated heat.

Humidity is fatal for electronic circuits. In areas subjected to high relative humidity, the O-rings for the electronic housing covers must be correctly placed and the covers must be completely closed by tightening them by hand until the O-rings are compressed.

Do not use tools to close the covers. Removal of the electronics cover in the field should be reduced to the minimum necessary, as each time it is removed; the circuits are exposed to the humidity. The electronic circuit is protected by a humidity proof coating, but frequent exposure to humidity may affect the protection provided. It is also important to keep the covers tightened in place. Every time they are removed, the threads are exposed to corrosion, since painting cannot protect these parts.

Although the transmitter is virtually insensitive to vibration, installation close to pumps, turbines or other vibrating equipment should be avoided.

Recommendation in using of DT302

The process fluid must always cover the two repeater diaphragms.

The maximum process fluid velocity over the two repeater diaphragms must be 0.4m/sec, what means a flow of $26 \text{ m}^3/\text{h}$ in a piping of ϕ 6". This information is according to fluids which viscosity is close to that water. For fluids where the viscosity is very different to that water viscosity should be analyzed. This limitation is due to the losing of load between the diaphragms.

For applications in corrosive fluids, compatible material with the process fluid must be chosen. Materials that are not in contact with the process, but can be in contact with the corrosive atmosphere or process residues also must be considered.

Verify if a possible leak of fill fluid (unless than 5ml), due an orifice in the diaphragm can contaminate the process. If it is not permitted, please, chose a compatible fill fluid.

Verify if the fill fluid does not evaporate in the conditions of limit temperatures and limit pressures of the process.

Models of DT302

DT302I - Industrial Model, for general use.

DT302S- Sanitary Model, for food, pharmaceutical industries and other applications where is necessary sanitary conditions.

The industrial model uses flanged connection according to the standard ANSI B16.5 or DIN 2526.

The sanitary model uses tri-clamp connection, allowing a fast connection to the process. The treatment of wet superficial is made according to the standard of rough 32 Ra. This method is according to the recommendation of 3A standard that is the sanitary standard largely used by food, medicines and drink industries.

Fixation

We have two types of fixation:

Top installation (**DT302**: straight type). Lateral installation (**DT302**: side type).

The dimensions of both types for industrial and sanitary models can be seen in the following figures.

The installation can be made in open or pressurized tanks or through an external sampler device from the process.

Some examples are shown in the following figures.

Choose a place with free access and free mechanical chock to install the device.

A - Industrial Model Top Mounting - Between Centre of the Sensors 250 mm

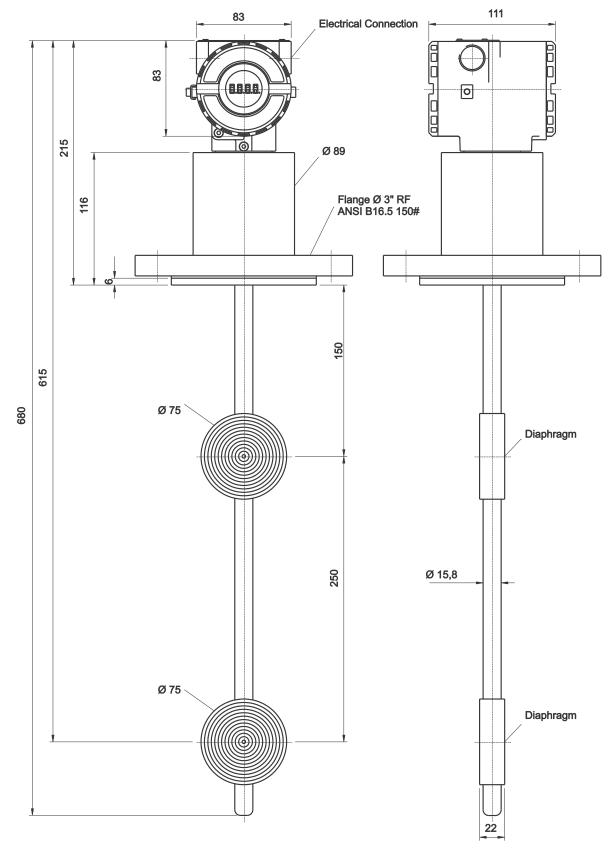


Figure 1.1 – DT302 Dimensional (A)

B – Industrial Model Side Mounting

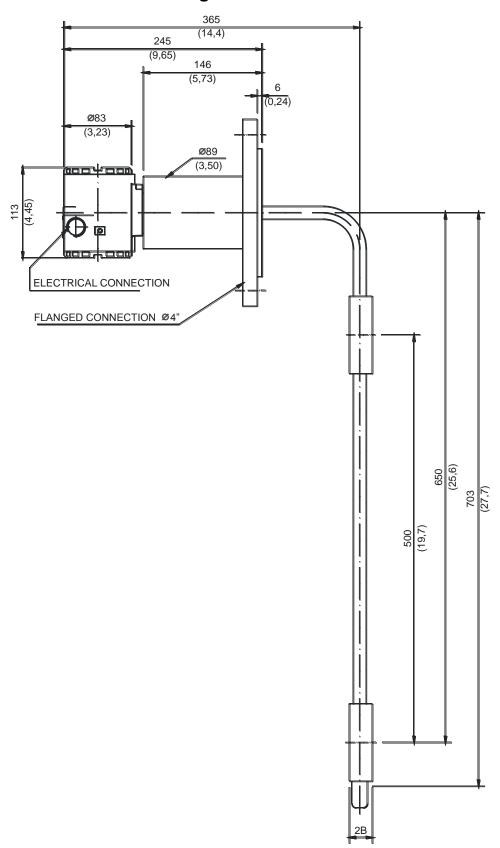


Figure 1.1 – DT302 Dimensional (B)

C - Sanitary Model Top Mounting - Between Centre of the Sensors 500 mm

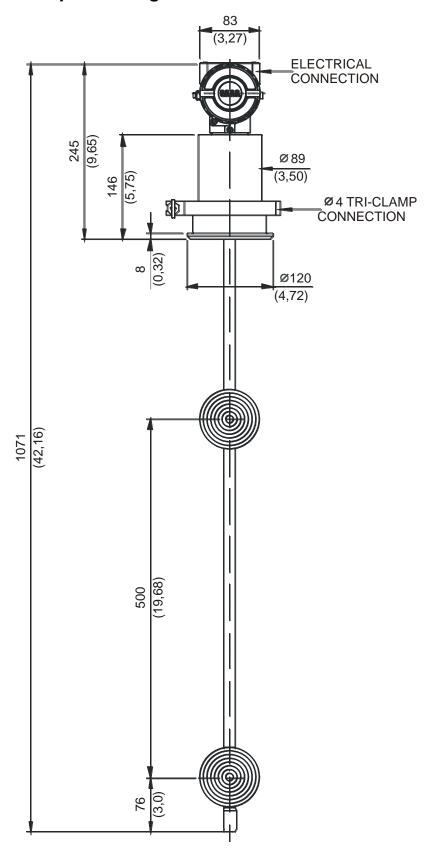


Figure 1.1 – DT302 Dimensional (C)

D - Sanitary Model Side Mounting

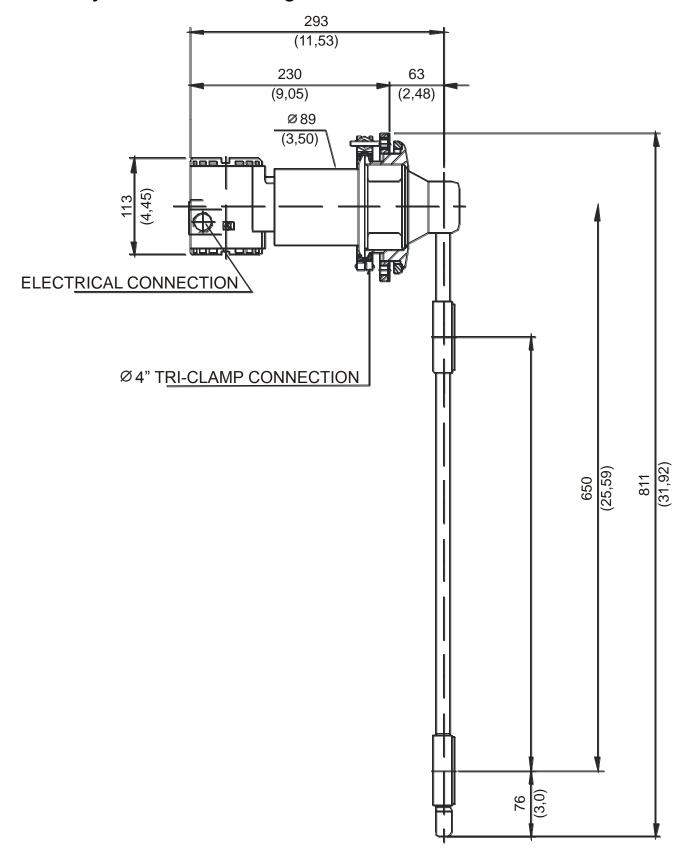


Figure 1.1 – DT302 Dimensional (D)

E – Industrial Model Top Mounting

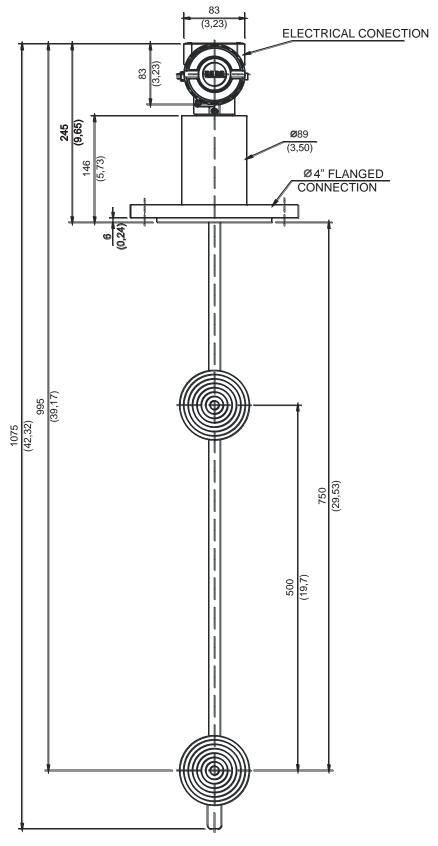


Figure 1.1 – DT302 Dimensional (E)

F – Sanitary Model Top Mounting - Between Centre of the Sensors 800 mm

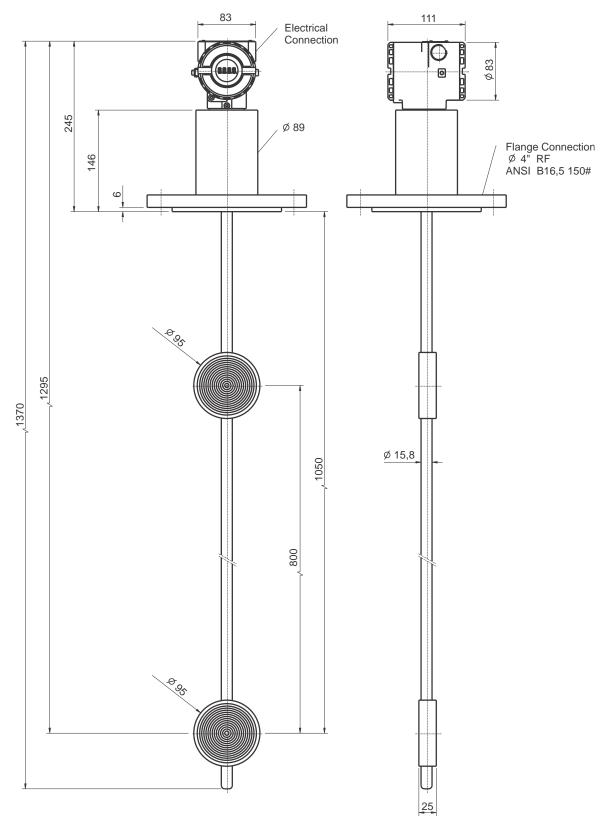


Figure 1.1 – DT302 Dimensional (F)

A – Typical Installation for Low Flow Tank (Industrial Model)

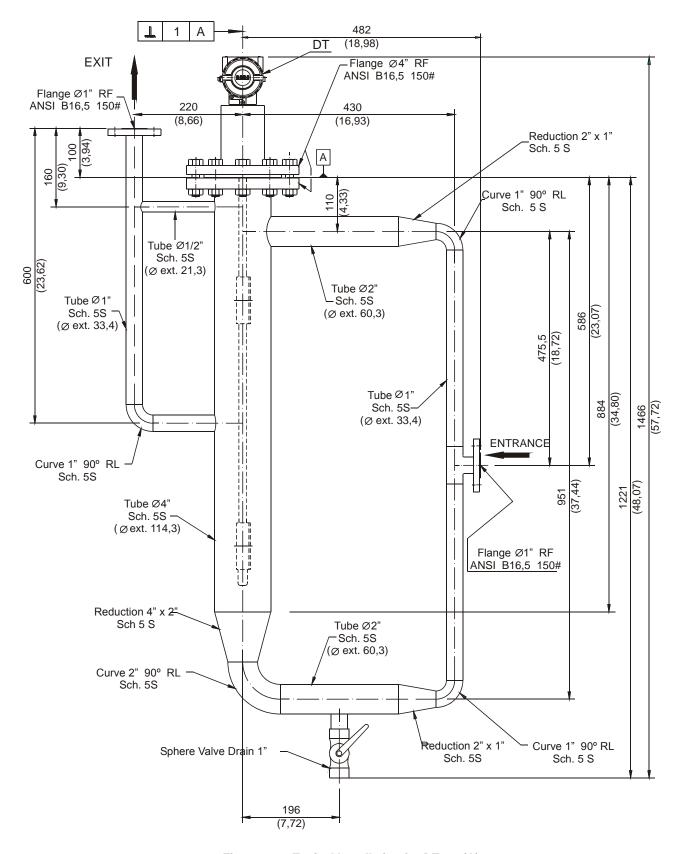


Figure 1.2 – Typical Installation for DT302 (A)

B – Typical Installation for Low Flow Tank (Sanitary Model)

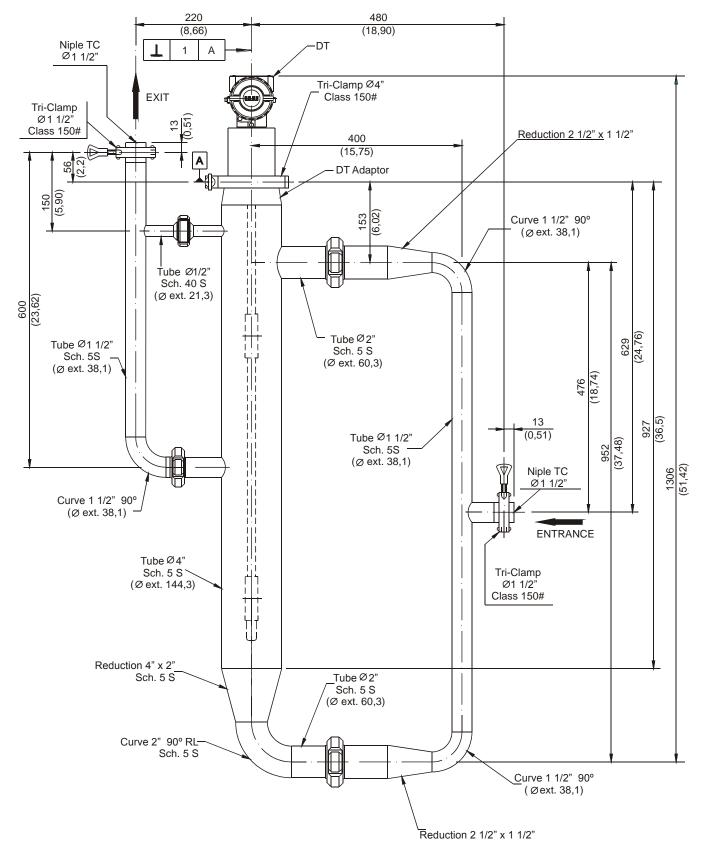


Figure 1.2 – Typical Installation for DT302 (B)

C – Typical Installation for High Flow Tank (Industrial Model)

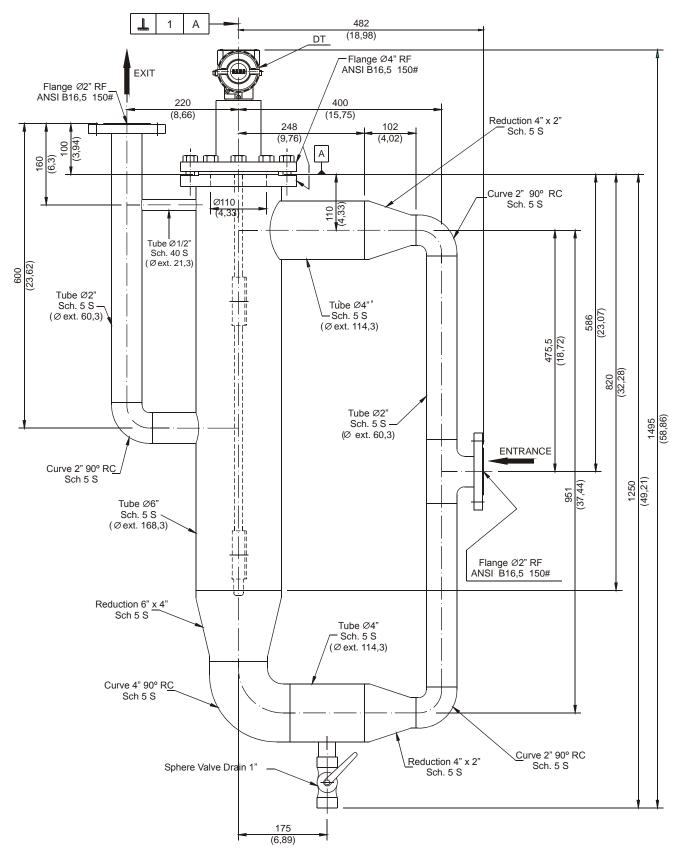


Figure 1.2 – Typical Installation for DT302 (C)

D – Typical Installation in Overflow Tanks

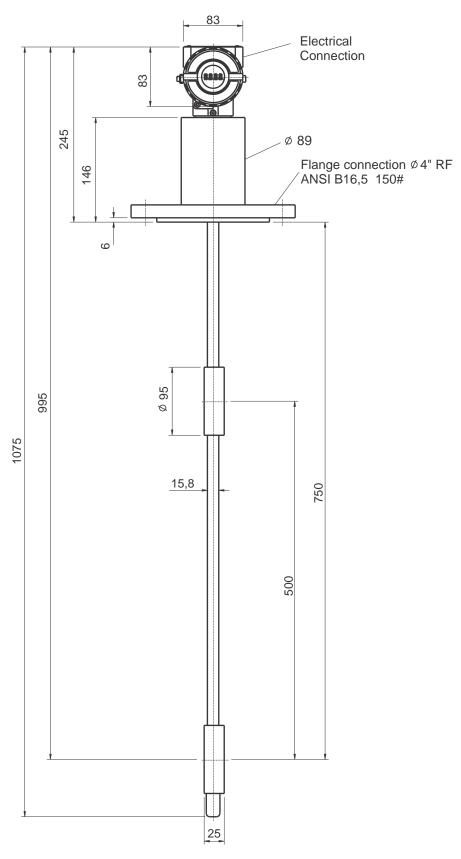


Figure 1.2 – Typical Installation for DT302 (D)

E – Typical Installation in Tank (Industrial Model)

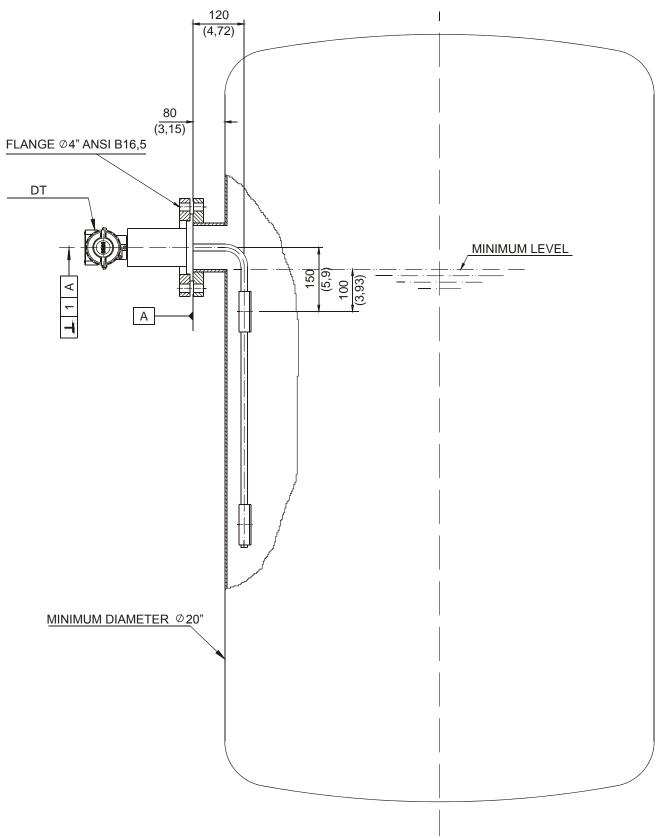


Figure 1.2 – Typical Installation for DT302 (E)

F – Typical Installation in Tank (Sanitary Model)

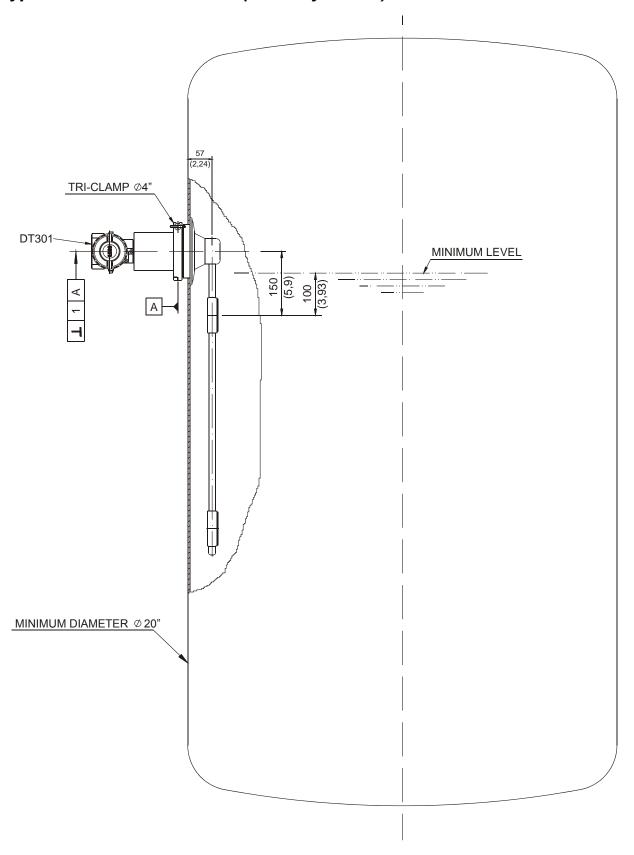


Figure 1.2 – Typical Installation for DT302 (F)

G - Typical Installation in Tank with Diaphragm Protection (Industrial Model)

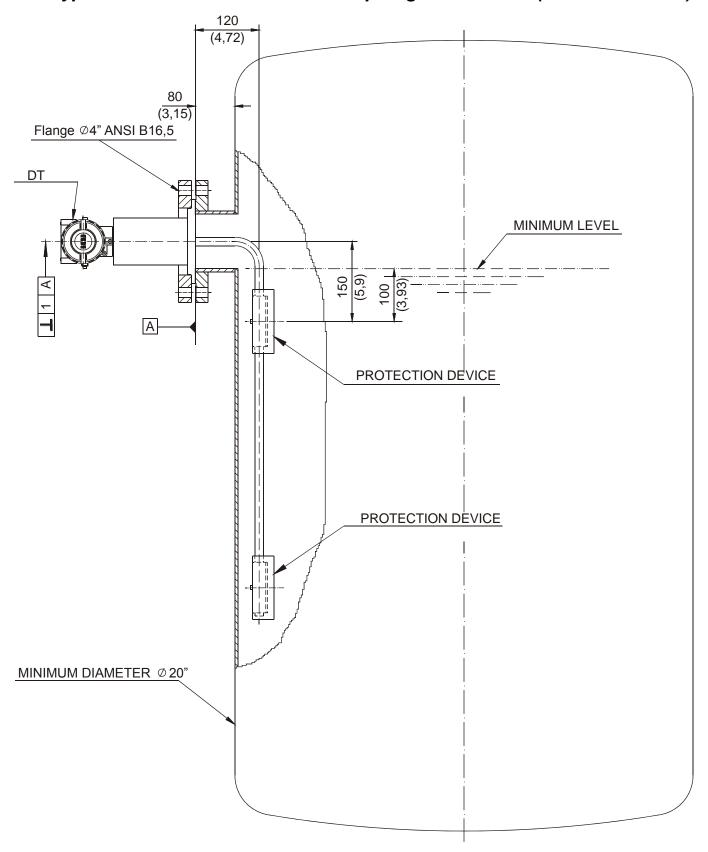


Figure 1.2 – Typical Installation for DT302 (G)

H - Typical Installation for Low Flow Tank (Industrial Model)

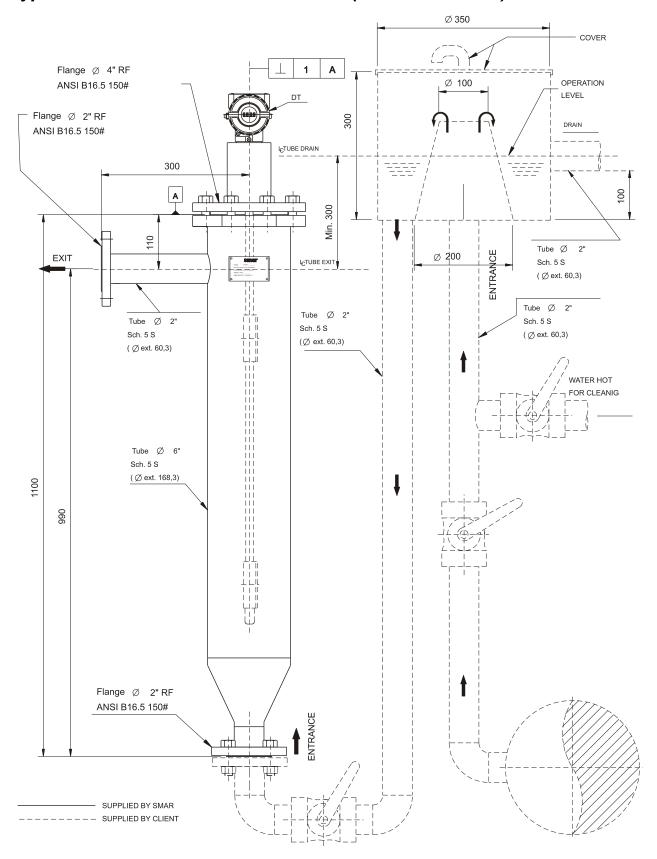


Figure 1.2 – Typical Installation for DT302 (H)

I - Typical Installation in Tank for Interface Level (Industrial Model)

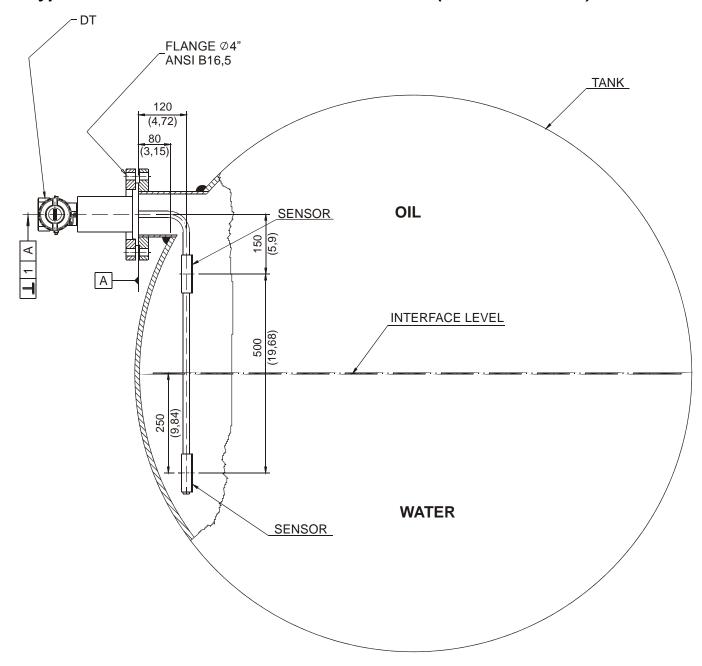


Figure 1.2 – Typical Installation for DT302 (I)

J - Typical Installation in Tank for Stand Pipe Interface Level (Industrial Model)

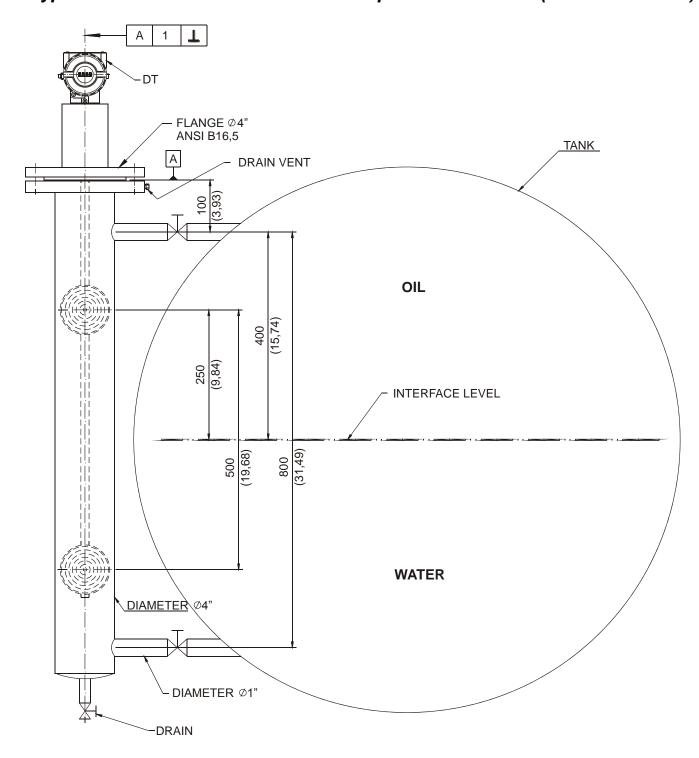


Figure 1.2 – Typical Installation for DT302 (J)

Housing Rotation

The housing can be rotated in order to get the digital display in better position. To rotate it, releases the Housing Rotation Set Screw.

The digital display itself can also be rotated. See Figure 4.2 – Four Possible Positions of the Display.

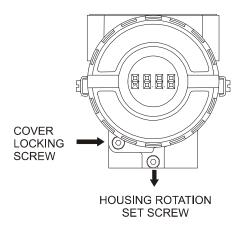


Figure 1.3 - Housing Rotation Set Screw

For convenience there are three ground terminals: one inside the cover and two externals, located close to the conduit entries.

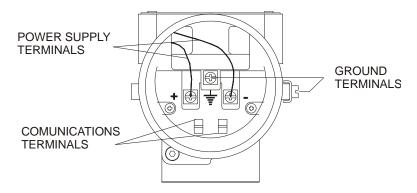


Figure 1.4 - Terminal Block

The **DT302** uses the 31.25 kbit /s voltage mode option for the physical signaling. All other devices on the same bus must use the same signaling. All devices are connected in parallel along the same pair of wires.

Various types of Fieldbus devices may be connected on the same bus.

The **DT302** receives power from the bus via the signal wiring. The power supply may come from a separate unit or from another device such as a controller or DCS.

In hazardous area, the number of devices may be limited by intrinsically safe restrictions, according to the barriers limitation.

The **DT302** is protected against reverse polarity, and can withstand ±35 VDC without damage, but it will not operate when in reverse polarity.

Bus Topology and Network Configuration

Wiring

Other types of cable may be used, other than for conformance testing. Cables with improved specifications may enable longer trunk length or superior interface immunity. Conversely, cables with inferior specifications may be used subject to length limitations for trunk and spurs plus possible nonconformance to the RFI/EMI susceptibility requirements. For intrinsically safe applications, the inductance/ resistance ratio (L/R) should be less than the limit specified by the local regulatory agency for the particular implementation.

Bus topology and tree topology are supported. Both types have a trunk cable with two terminations. The devices are connected to the trunk via spurs. The spurs may be integrated in the device giving zero spur length. A spur may connect more than one device, depending on the length. Active couplers may be used to extend spur length.

Active repeaters may be used to extend the trunk length. The total cable length, including spurs, between any two devices in the Fieldbus should not exceed 1900m.

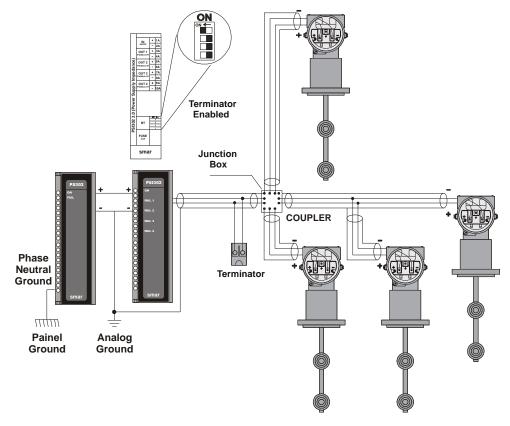


Figure 1.5 - Bus Topology

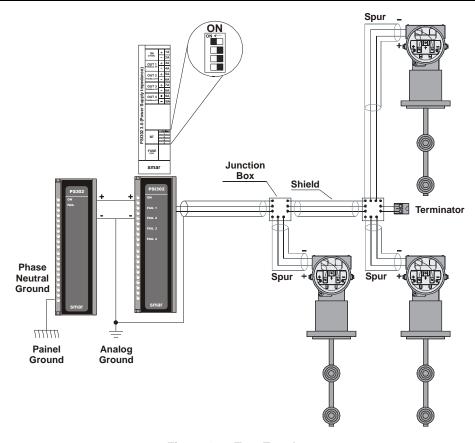


Figure 1.6 - Tree Topology

Intrinsic Safety Barrier

When the Fieldbus is in hazardous location with Explosive Atmosphere, the protection type "intrinsic safety (Ex-i)" can be used with a barrier inserted on the trunk between the power supply and the Fieldbus bus.

Use of SB312LP, DF47-12 or DF47-17 is recommended.

Jumper Configuration

In order to work properly, the jumpers J1 and W1 located in the **DT302** main board must be correctly configured (See *Table 1.1 - Description of the Jumpers*).

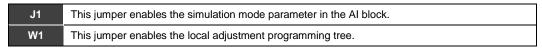


Table 1.1 - Description of the Jumpers

Power Supply

The **DT302** receives power from the bus via the signal wiring. The power supply may come from a separate unit or from another device such as a controller or DCS.

The voltage should be between 9 to 32 Vdc for non-intrinsic safe applications.

A special requirement applies to the power supply used in an intrinsically safe bus and depends on the type of barrier used.

Use of **PS302** is recommended as power supply.

Installation in Hazardous Areas



WARNING

Explosions could result in death or serious injury, besides financial damage. Installation of this transmitter in explosive areas must be carried out in accordance with the local standards and the protection type adopted. Before continuing the installation make sure the certificate parameters are in accordance with the classified area where the equipment will be installed.

The instrument modification or parts replacement supplied by other than authorized representative of Smar is prohibited and will void the certification.

The transmitters are marked with options of the protection type. The certification is valid only when the protection type is indicated by the user. Once a particular type of protection is selected, any other type of protection can not be used.

The electronic housing and the sensor installed in hazardous areas must have a minimum of 6 fully engaged threads. Lock the housing using the locking screw (Figure 1.3).

The cover must be tighten with at least 8 turns to avoid the penetration of humidity or corrosive gases. The cover must be tighten until it touches the housing. Then, tighten more 1/3 turn (120°) to guarantee the sealing. Lock the covers using the locking screw (Figure 1.3).

Consult the Appendix A for further information about certification.

Explosion/Flame Proof



WARNING

The electric connection's entries must be connected or closed using the appropriate Ex-d metal cable gland and/or metal blanking plug with certified IP66 rating.

As the transmitter is non-ignition capable under normal conditions, the statement "Seal not Required" could be applied for Explosion Proof Version. (CSA Certification).

The standard plugs provided by Smar are certified according to the standards at FM, CSA and CEPEL. If the plug needs to be replaced, a certified plug must be used.

In the electrical connection with NPT thread, for waterproofing installation, use a non-hardening silicone sealant.

Do not remove the transmitter covers when power is ON.

Intrinsically Safe



WARNING

In hazardous zones with intrinsically safe or non-incendive requirements, the circuit entity parameters and applicable installation procedures must be observed.

To protect the application the transmitter **must be connected to a barrier**. Match the parameters between barrier and the equipment (Consider the cable parameters). Associated apparatus ground bus shall be insulated from panels and mounting enclosures. Shield is optional. If used, be sure to insulate the end not grounded. Cable capacitance and inductance plus Ci and Li must be smaller than Co and Lo of the associated Apparatus.

It is not recommended to remove the transmitter cover when the power is ON.

OPERATION

The **DT302** Concentration Density Transmitter use capacitive sensors (capacitive cells) as pressure sensing elements. This is exactly the same sensor as the DT301 series uses, the sensor modules are therefore interchangeable.

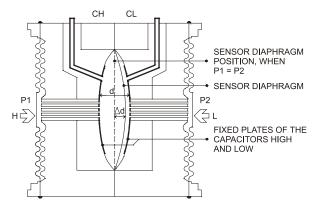


Figure 2.1 - Capacitive Cell

Functional Description - Sensor

Where,

 P_1 and P_2 are the pressures and $P_1 \ge P_2$

CH = Capacitance between the fixed plate on P_1 side and the sensing diaphragm.

CL = Capacitance between the fixed plate on the P₂ side and the sensing diaphragm.

d = Distance between CH and CL fixed plates.

 Δd = Sensing diaphragm's deflection due to the differential pressure ΔP = P_1 - P_2 .

Knowing that the capacitance of a capacitor with flat, parallel plates may be expressed as a function of plate area (A) and distance (d) between the plates:

$$C \approx \frac{\varepsilon \times A}{d}$$

Where,

 ε = Dielectric constant of the medium between the capacitor's plates.

$$CH \approx \frac{\varepsilon \times A}{(d/2) + \Delta d}$$
 and $\frac{\varepsilon \times A}{(d/2) - \Delta d} \approx CL$

However, should *CH* and *CL* be considered as capacitances of flat and parallel plates with identical areas, then:

However, should the differential pressure (ΔP) applied to the capacitive cell not deflect the sensing diaphragm beyond d/4, it is possible to assume ΔP as proportional to Δd , that is:

$$\Delta P \propto \Delta d$$

By developing the expression (CL - CH)/(CL + CH), it follows that:

$$\frac{CL - CH}{CL + CH} = \frac{2\Delta d}{d}$$

As the distance (d) between the fixed plates CH and CL is constant. It is possible to conclude that the expression (CL - CH)/ (CL + CH) is proportional to Δd and, therefore, to the differential pressure to be measured.

Thus it is possible to conclude that the capacitive cell is a pressure sensor formed by two capacitors whose capacitance varies according to the applied differential pressure.

Functional Description – Electronics

Refer to the block diagram. The function of each block is described below.

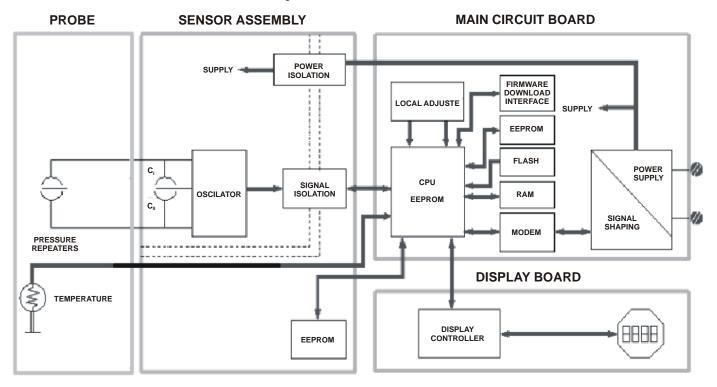


Figure 2.2 - DT302 Block Diagram Hardware

Probe

Part of the transmitter directly in contact with the process.

Pressure Repeaters

It transfers to the capacitive sensor the differential pressure detected in the process.

Temperature Sensor

It captures the process fluid temperature.

Oscillator

This oscillator generates a frequency as a function of sensor capacitance.

Signal Isolator

The control signals from the CPU and the signal from the oscillator are isolated to avoid ground loops.

Central Processing Unit (CPU), RAM, FLASH and EEPROM

The CPU is the intelligent portion of the transmitter, being responsible for the management and operation of measurement, block execution, self-diagnostics and communication. The program is stored in a FLASH memory for easy upgrade and saving data on power-down event occurrence. For temporary storage of data there is a RAM. The data in the RAM is lost if the power is switched off, however the main board has a nonvolatile EEPROM memory where the static data configured that must be retained is stored. Examples of such data are the following: calibration, links and identification data.

Sensor EEPROM

Another EEPROM is located within the sensor assembly. It contains data pertaining to the sensor's characteristics at different pressures and temperatures. This characterization is done for each sensor at the factory. It also contains the factory settings; they are useful in case of main board replacement, when it does an automatic upload of data from the sensor board to main board.

Fieldbus Modem

Monitors line activity, modulate and demodulate communication signals, inserts and deletes start and end delimiters, and checks integrity of frame received.

Power Supply

Takes power of the loop-line to power the transmitter circuitry.

Power Isolation

Isolates the signals to and from the input section, the power to the input section must be isolated.

Display Controller

Receives data from the CPU identifying which segments on the liquid crystal display to turn on. The controller drives the backplane and the segment control signals.

Local Adjustment

There are two switches that are magnetically activated. They can be activated by the magnetic tool without mechanical or electrical contact.

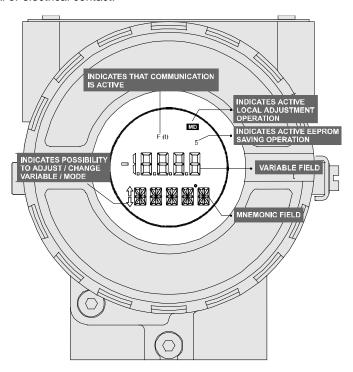


Figure 2.3 - LCD Indicator

CONFIGURATION

One of the many advantages of Fieldbus is that device configuration is independent of the configurator. The **DT302** may be configured by a third party terminal or operator console. Any particular configurator is therefore not addressed here.

The **DT302** contain one input transducer block, one resource, one display transducer block and functions blocks. Functions Blocks are not covered in this manual. For explanation and details see the "Functions Blocks Manual".

Transducer Block

Transducer block insulates function block from the specific I/O hardware, such as sensors, actuators. Transducer block controls access to I/O through manufacturer specific implementation. This permits the transducer block to execute as frequently as necessary to obtain good data from sensors without burdening the function blocks that use the data. It also insulates the function block from the manufacturer specific characteristics of certain hardware.

By accessing the hardware, the transducer block can get data from I/O or passing control data to it. The connection between Transducer block and Function block is called channel. These blocks can exchange data from its interface. Normally, transducer blocks perform functions, such as linearization, characterization, temperature compensation, control and exchange data to hardware.

Transducer Block Diagram

See transducer block diagram below.

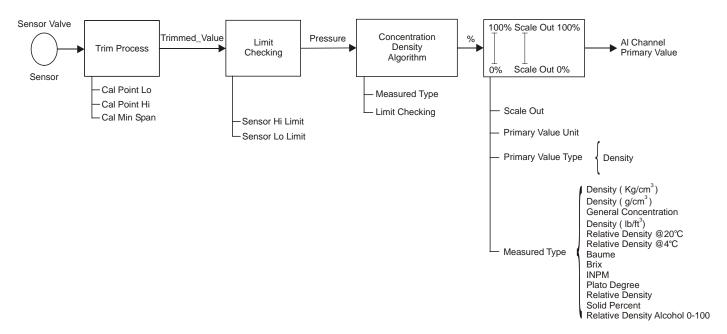


Figure 3.1 - Transducer Block Diagram

Concentration/Density Transducer Block Parameter Description

Parameter	Description
ST REV	Indicates the level of static data.
TAG DESC	Transducer block description.
STRATEGY	This parameter is not checked and processed by transducer block.
ALERT_KEY	Number of identification in the plant.
MODE_BLK	Indicates the operation mode of transducer block.
BLOCK_ERR	Indicates the status associated with hardware or software in the transducer.
UPDATE_EVT	Alert for any static data.
BLOCK_ALM	Used for configuration, hardware and other fail.
TRANSDUCER_DIRECTORY	Used to select several transducer blocks.
TRANSDUCER_TYPE	Indicates the type of transducer according to its class.
XD_ERROR COLLECTION_DIRECTORY	Used to indicate calibration status. Specifies the number of transducer index into transducer block.
PRIMARY_VALUE_TYPE	Defines the calculation type for transducer block.
PRIMARY VALUE	Value and status used by channel.
	High and low range limit values, the engineering unit code and the number of digits to the
PRIMARY_VALUE_RANGE	right of the decimal point to be used for primary value.
CAL_POINT_HI	Highest calibrated value.
CAL_POINT_LO	Lowest calibrated value.
	Minimum calibration span value allowed. This minimum span information is necessary to
CAL_MIN_SPAN	ensure that when calibration is done, the two calibrated points (high and low) are not too
CAL UNIT	close together.
	Device description engineering units code index for the calibration values.
SENSOR_TYPE SENSOR_RANGE	Type of sensor. Range of sensor.
SENSOR SN	Serial number of sensor.
	Method of last sensor calibration, ISO defines several standard methods of calibration. This
SENSOR_CAL_METHOD	parameter is intended to record that method, or if some other method was used.
SENSOR CALLOC	Location of last sensor calibration. This describes the physical location at which the
SENSOR_CAL_LOC	calibration was performed.
SENSOR_CAL_DATE	Date of the last sensor calibration.
SENSOR_CAL_WHO	Name of person who is in charge of last calibration.
SENSOR_ISOLATION_MTL	Defines the construction material of the isolating diaphragms.
SENSOR_FLUID	Defines the type of fill fluid used in the sensor
SECONDARY_VALUE SECONDARY_VALUE_UNIT	Secondary value (temperature value), related to the sensor. Engineering units to be used with SECONDARY_VALUE.
PRESS LIN NORMAL	Linear normalized pressure value.
PRESS_NORMAL	Normalized pressure value.
PRESS_CUTOFF	Cutoff pressure value.
CUTOFF FLAG	Bypass flag for Pressure value.
DIGITAL_TEMPERATURE	Digital temperature value.
DIFF	Differential pressure value.
YDIFF	Differential pressure value.
CAPACITANCE_LOW	Low capacitance value.
CAPACITANCE_HIGH	High capacitance value.
BACKUP_RESTORE	This parameter is used to do backup or to restore configuration data.
SENSOR_RANGE_CODE	Indicates the sensor range code.
COEFF_POL0	Polynomial coefficient 0. Polynomial coefficient 1.
COEFF_POL1 COEFF_POL2	Polynomial coefficient 1.
COEFF_POL3	Polynomial coefficient 3.
COEFF_POL4	Polynomial coefficient 4.
COEFF_POL5	Polynomial coefficient 5.
COEFF_POL6	Polynomial coefficient 6.
COEFF_POL7	Polynomial coefficient 7.
COEFF_POL8	Polynomial coefficient 8.
COEFF_POL9	Polynomial coefficient 9.
COEFF_POL10	Polynomial coefficient 10.
COEFF_POL11	Polynomial coefficient 11.
POLYNOMIAL_VERSION	Indicates the polynomial version.
CHARACTERIZATION_TYPE	Indicates the type of characterization curve.
CURVE _BYPASS_LD	Enable and disable the characterization curve.
CURVE_LENGTH	Indicates the length of characterization curve.
CURVE_X	Input points of characterization curve.
CURVE_Y CAL_POINT_HI_BACKUP	Output points of characterization curve. Indicates the backup for high calibration point.
OUT LINI THE DACKOR	muicates the backup for high cambiation point.

Dovometer	Description
Parameter CAL POINT LO PACKUR	Description
CAL_POINT_LO_BACKUP CAL_POINT_HI_FACTORY	Indicates the backup for low calibration point. Indicates the factory high calibration point.
CAL_POINT_LO_FACTORY	Indicates the factory high calibration point. Indicates the factory low calibration point.
CAL TEMPERATURE	Defines the temperature calibration point.
DATASHEET	Indicates information about the sensor.
ORDERING_CODE	Indicates information about the sensor and control from factory production.
MAXIMUM_MEASURED_PRESSURE	Indicates the maximum pressure measured.
MAXIMUM_MEASURED_TEMPERATURE	Indicates the maximum temperature measured.
ACTUAL_OFFSET	Indicates the actual calibrated offset.
ACTUAL_SPAN	Indicates the actual span offset.
MAXIMUM_OFFSET_DEVIATION	Defines the maximum offset before an alarm is generated.
MAXIMUM_GAIN_DEVIATION OVERPRESSURE LIMIT	Defines the maximum gain before an alarm is generated. Defines the maximum overpressure limit before an alarm is generated.
MAXIMUM_NUMBER_OF_OVERPRESSURE	Defines the maximum number of overpressure before an alarm is generated.
GRAVITY	Gravity acceleration used in concentration/density calculation. The unit is m/s².
HEIGHT	Distance between the two pressure sensors. The unit is m.
	When the transducer type is density, it allows to measure:
	0 - Density (g/cm³),
	1 - Density (Kg/m³),
	2 - Relative Density @ 20°C (g/cm³),
	3 - Relative Density @ 4°C (g/cm³), 4 - Baume,
MEASURED_TYPE	5 - Brix,
	6 - Plato Degree,
	7 - INPM,
	8 - Relative Density Alcohol 0 - 100,
	9 - Solid Percent, 10 - Density (lb/ft³)
	11 - API
LIN DILATATION COEF	Linear dilatation coefficient.
PRESSURE_COEFFICIENT	Coefficient of pressure.
TEMP_ZERO	Offset coefficient used to calculate the temperature.
TEMP_GAIN	Gain coefficient used to calculate the temperature.
ZERO_ADJUST_TEMP	Temperature of zero adjustment.
HEIGHT_MEAS_TEMP	Temperature of measurement of distance between the pressure sensors.
AUTO_CAL_POINT_LO	This parameter enables the lower self-calibration point. The sensor should be in air and the MEASURED_TYPE and XD_SCALE.UNIT should be Kg/cm³. The calibration point is 1.2
AOTO_CAL_TONY_LO	Kg/cm ³ .
	This parameter enables the upper self-calibration point. The sensor should be on water and
AUTO_CAL_POINT_HI	the MEASURED_TYPE AND XD_SCALDE.UNIT should be Brix. The calibration point is 0
	Brix.
SOLID_POL_COEFF_0	Solid percent polynomial coefficient 0.
SOLID_POL_COEFF_1	Solid percent polynomial coefficient 1.
SOLID_POL_COEFF_2	Solid percent polynomial coefficient 2.
SOLID_POL_COEFF_3 SOLID_POL_COEFF_4	Solid percent polynomial coefficient 3. Solid percent polynomial coefficient 4.
SOLID_POL_COEFF_5	Solid percent polynomial coefficient 5.
SOLID LIMIT LO	Solid percent limit low.
SOLID_LIMIT_HI	Solid percent limit high.
PRESS_COMP	Value used by the factory.
SIMULATE_PRESS_ENABLE	Enable the concentration simulation mode.
SIMULATE_PRESS_VALUE	Simulate pressure value in mmH ₂ O at 68 °F. Used together with
	SIMULATE_PRESS_ENABLE.
SIMULATE_DENSITY_VALUE	Density value used to obtain the correspondent pressure.
CALCULATED_PRESS_VALUE CALC_PRESS_CAL_POINT_LO	Pressure calculated according to the SIMULATE_DENSITY_VALUE. Calculated pressure value by AUTO_CAL_POINT_LO procedure.
CALC_PRESS_CAL_POINT_LO CALC_PRESS_CAL_POINT_HI	Calculated pressure value by AUTO_CAL_POINT_LO procedure. Calculated pressure value by AUTO_CAL_POINT_HI procedure.
ONEO_I NEGO_ONE_I OINI_III	DT302 range code:
DT BANCE CODE	Range 1 (0.5 @ 1.8 g/cm ³)
DT_RANGE_CODE	Range 2 (1.0 @ 2.5 g/cm ³)
	Range 3 (2.0 @ 5.0 g/cm ³)
DENSITY_KGM3	Density Value in Kg/m3.
DENSITY_STATUS	Density status information such as temperature between limits.
CONC	18 polynomial terms.
HI_LIM_DENS LO_LIM_DENS	Density upper limit for generic concentration. Density lower limit for generic concentration.
HI_LIM_TEMP	Temperature upper limit for generic concentration.
LO LIM TEMP	Temperature lower limit for generic concentration.
K_DENS	Density constant used to calculate generic concentration.
''-	a significant design of the sign of

Parameter	Description
K_TEMP	Temperature constant used to calculate generic concentration.
MOUNTING POSITION	Indicates de probe assembly position (direct or reverse).

Table 3.1 – Concentration/Density Transducer Block Parameter Description

Concentration/Density Transducer Block Parameter Attributes

Relative Index	Parameter Mnemonic	Object Type	Data Type	Store	Size	Access	Default -value
1	ST_REV	Simple	Unsigned16	S	2	R/W	0
2	TAG_DESC	Simple	VisibleString	S	32	R/W	TRD BLOCK
3	STRATEGY	Simple	Unsigned16	S	2	R/W	0
4				S	1	R/W	0
	ALERT_KEY	Simple	Unsigned8				
5	MODE_BLK	Record	DS-69	S	4	R/W	O/S
6	BLOCK_ERR	Simple	Bit String	D	2	R	
7	UPDATE_EVT	Record	DS-73	D	5	R	
8	BLOCK_ALM	Record	DS-72	D	13	R	
9	TRANSDUCER_DIRECTORY	Simple	Array of Unsigned16	N	Variable	R	
10	TRANSDUCER_TYPE	Simple	Unsigned16	N	2	R	100
11	XD_ERROR	Simple	Unsigned8	D	1	R	0
12	COLLECTION_DIRECTORY	Simple	Array of Unsigned 32	S	Variable	R	
13	PRIMARY_VALUE_TYPE	Simple	Unsigned16	S	2	R/W	107
14	PRIMARY_VALUE	Record	DS-65	D	5	R	0
15	PRIMARY_VALUE_RANGE	Record	DS-68	S	11	R	
16	CAL_POINT_HI	Simple	Float	S	4	R/W	5080.0
17	CAL_POINT_LO	Simple	Float	S	4	R/W	0.0
18	CAL_MIN_SPAN	Simple	Float	S	4	R	0.0
19 20	CAL_UNIT SENSOR_TYPE	Simple Simple	Unsigned16	S S	2	R/W	1149 117
21	SENSOR RANGE	Record	Unsigned16 DS-68	S	11	R/W R	0-100%
22	SENSOR_SN	Simple	Unsigned32	S	4	R/W	0-10078
23	SENSOR_CAL_METHOD	Simple	Unsigned8	S	1	R/W	103
24	SENSOR_CAL_LOC	Simple	VisibleString	S	32	R/W	NULL
25	SENSOR_CAL_DATE	Simple	Time of Day	S	7	R/W	1.10==
26	SENSOR_CAL_WHO	Simple	VisibleString	S	32	R/W	NULL
27	SENSOR_ISOLATION_MTL	Simple	Unsigned16	S	2	R/W	2
28	SENSOR_FLUID	Simple	Unsigned16	S	2	R/W	1
29	SECONDARY_VALUE	Record	DS-65	D	5	R	0
30	SECONDARY_VALUE_UNIT	Simple	Unsigned16	S	2	R	1001 (°C)
31	PRESS_LIN_NORMAL	Record	DS-65	D	5	R	0
32	PRESS_NORMAL	Record	DS-65	D	5	R	0
33	PRESS_CUTOFF	Record	DS-65	D	5	R	0
34	CUTOFF_FLAG	Simple	Unsigned8	S	1	R/W	True
35	DIGITAL_TEMPERATURE	Record	DS-65	D	5	R	0
36 37	DIFF YDIFF	Simple Simple	Float Float	D D	4	R R	0
38	CAPACITANCE_LOW	Simple	Float	D	4	R	0
39	CAPACITANCE_LOW	Simple	Float	D	4	R	0
40	BACKUP_RESTORE	Simple	Unsigned8	S	1	R/W	0
41	SENSOR_RANGE_CODE	Simple	Unsigned16	S	2	R/W	1
42	COEFF_POL0	Simple	Float	S	4	R/W	-1
43	COEFF_POL1	Simple	Float	S	4	R/W	0
44	COEFF_POL2	Simple	Float	S	4	R/W	1
45	COEFF_POL3	Simple	Float	S	4	R/W	0
46	COEFF_POL4	Simple	Float	S	4	R/W	2
47	COEFF_POL5	Simple	Float	S	4	R/W	0
48	COEFF_POL6	Simple	Float	S	4	R/W	0
49	COEFF_POL7	Simple	Float	S	4	R/W	0
50	COEFF_POL8	Simple	Float	S	4	R/W	0
51	COEFF_POL9	Simple	Float	S	4	R/W	0
52	COEFF_POL10	Simple	Float	S	4	R/W	0
53	COEFF_POL11	Simple	Float	S	4	R/W	25

Relative	Parameter Mnemonic	Object	Data Type	Store	Size	Access	Default -value
Index		Type			SIZE		Delault -value
54	POLYNOMIAL_VERSION	Simple	Unsigned8	S	1	R/W	32
55	CHARACTERIZATION_TYPE	Simple	Unsigned8	S	1	R/W	255
56	CURVE _BYPASS_LD	Simple	Unsigned16	S	2	R/W	Enable&Backup Cal
57	CURVE_LENGTH	Simple	Unsigned8	S	1	R/W	5
58	CURVE_X	Record	Array of Float	S	20	R/W	
59	CURVE_Y	Record	Array of Float	S	20	R/W	
60	CAL_POINT_HI_BACKUP	Simple	Float	S	4	R	5080
61	CAL_POINT_LO_BACKUP	Simple	Float	S	4	R	0
62	CAL_POINT_HI_FACTORY	Simple	Float	S	4	R	5080
63 64	CAL_POINT_LO_FACTORY CAL_TEMPERATURE	Simple Simple	Float Float	S	4	R/W	0 17.496
64	CAL_TEMPERATURE	Simple			4	FC/VV	17.490
65	DATASHEET	Record	Array of Unsigned8	S	10	R/W	
66	ORDERING_CODE	Simple	VisibleString	S	50	R/W	NULL
67	MAXIMUM_MEASURED_PRESSURE	Simple	Float	S	4	R/w	- INF
68	MAXIMUM_MEASURED_TEMPERAT URE	Simple	Float	S	4	R/W	- INF
69	ACTUAL_OFFSET	Simple	Float	S	4	R	
70	ACTUAL_SPAN	Simple	Float	S	4	R	
71	MAXIMUM_OFFSET_DEVIATION	Simple	Float	S	4	R/W	0.5
72	MAXIMUM_GAIN_DEVIATION	Simple	Float	S	4	R/W	2.0
73	OVERPRESSURE_LIMIT	Simple	Float	S	4	R/W	+ INF
74	MAXIMUM_NUMBER_OF_OVERPRE SSURE	Simple	Float	S	4	R/W	0
75	GRAVITY	Simple	Float	S	4	R/W	9.80665
76	HEIGHT	Simple	Float	S	4	R/W	0.500
77	MEASURED_TYPE	Simple	Float	S	4	R/W	0
78	LIN_DILATATION_COEF	Simple	Float	S	4	R/W	0.000016
79	PRESSURE_COEFFICIENT	Simple	Float	S	4	R/W	
80	TEMP_ZERO	Simple	Float	S	4	R/W	-30
81	TEMP_GAIN	Simple	Float	S	4	R/W	0.5
82	ZERO_ADJUST_TEMP	Simple	Float	S	4	R/W	20
83	HEIGHT_MEAS_TEMP	Simple	Float	S	4	R/W	0.5
84	AUTO_CAL_POINT_LO	Simple	Float	S	4	R/W	0
85	AUTO_CAL_POINT_HI	Simple	Float	S	4	R/W	0
86	SOLID_POL_COEFF_0	Simple	Float	S	4	R/W	0
87	SOLID_POL_COEFF_1	Simple	Float	S	1	R/W	1
88	SOLID_POL_COEFF_2 SOLID_POL_COEFF_3	Simple	Float Float	S	4	R/W R/W	0
89 90	SOLID_POL_COEFF_4	Simple Simple	Float	S	4	R/W	0
90	SOLID_FOL_COEFF_4	Simple	Float	S	4	R/W	0
92	SOLID_LIMIT_LO	Simple	Float	S	4	R/W	0
93	SOLID_LIMIT_HI	Simple	Float	S	4	R/W	100
94	PRESS_COMP	Simple	Float	D	4	R	0
95	SIMULATE_PRESS_ENABLE	Simple	Unsigned 8	D	1	R/W	Disable
96	SIMULATE_PRESS_VALUE	Simple	Float	D	4	R/W	0
97	SIMULATE_DENSITY_VALUE	Simple	Float	D	4	R/W	0
98	CALCULATED_PRESS_VALUE	Simple	Float	D	4	R	0
99	CALC_PRESS_CAL_POINT_LO	Simple	Float	D	4	R	0
100	CALC_PRESS_CAL_POINT_HI	Simple	Float	D	4	R	0
101	DT_RANGE_CODE	Simple	Unsigned 8	S	1	R/W	0
102	DENSITY_KGM3	Simple	Float	S	4	R	-
103	DENSITY_STATUS	Simple	Unsigned	S	1	R	-
104	CONC	Record	Array of Float	D	72	R/W	0
105	HI_LIM_DENS	Simple	Float	D	4	R/W	0
106	LO_LIM_DENS	Simple	Float	D	4	R/W	0
107	HI_LIM_TEMP	Simple	Float	D	4	R/W	0
108	LO_LIM_TEMP	Simple	Float	D	4	R/W	0
109	K_DENS	Simple	Float	D	4	R/W	1
110	K_TEMP	Simple	Float	D	4	R/W	1
111	MOUNTING_POSITION	Simple	Unsigned	D	1	R/W	-

Table 3.2 – Concentration/Density Transducer Blocks Parameter Attributes

Concentration/Density Transducer Block View Object

ST.REV						
1 ST.REV 2 2 2 2 2 2 2 2 2	Relative	Parameter Mnemonic	View_1	View_2	View_3	View_4
2 TAĞ DESC 3 SITATEGY 4 ALERT KEY 5 MODE BILK 6 BLOCK ERR 7 UPDATE EVT 8 BLOCK ALM 9 TRANSDUCER DIRECTORY 10 TRANSDUCER TYPE 11 XD ERROR 11 TANSDUCER TYPE 12 COLLECTION DIRECTORY 13 PRIMARY VALUE TYPE 14 PRIMARY VALUE TYPE 15 PRIMARY VALUE TYPE 16 CAL POINT III 17 CAL POINT LO 18 CAL LIVIT 19 CAL LIVIT 19 CAL LIVIT 19 CAL LIVIT 19 CAL LIVIT 20 SENSOR RANGE 11 TAL LIVIT 21 SENSOR RANGE 21 SENSOR CAL METHOD 22 SENSOR CAL METHOD 33 SENSOR CAL DATE 24 SENSOR CAL DATE 25 SENSOR CAL DATE 26 SENSOR CAL DATE 27 SENSOR RANGE 28 SENSOR CAL DATE 29 SECONDARY VALUE 20 SENSOR TUID 20 SENSOR ROMAL 31 PRESS LIVINORMAL 32 PRESS LIVINORMAL 33 PRESS CONTOFF 34 CUTOFF FLAG 35 DIFF 36 DIFF 37 VIDIF 38 CAPACITANCE LOW 39 CAPACITANCE LOW 40 BACKUP RESTORE 41 SENSOR RANGE 51 CAL DATE 41 SENSOR RANGE 52 SENSOR CAL DATE 43 SENSOR CAL DATE 44 SENSOR CAL DATE 55 SENSOR SON SECONDARY VALUE 56 SENSOR CAL DATE 57 SENSOR SON SECONDARY VALUE 58 SENSOR CAL DATE 59 SECONDARY VALUE 50 SECONDARY VALUE 50 SECONDARY VALUE 51 CAL POINT SECONDARY VALUE 52 SENSOR SON SECONDARY VALUE 54 SENSOR CAL DATE 55 SENSOR SON SECONDARY VALUE 56 SENSOR CAL SECONDARY VALUE 57 SENSOR SON SON SECONDARY VALUE 58 SENSOR FLUID 59 SECONDARY VALUE 50 SECONDARY VALUE 50 SECONDARY VALUE 51 SENSOR SON SON SECONDARY VALUE 51 SENSOR SON SON SECONDARY VALUE 52 SENSOR SON SON SECONDARY VALUE 54 SENSOR SON SON SECONDARY VALUE 55 SENSOR SON SON SECONDARY VALUE 56 SENSOR SON SON SON SECONDARY VALUE 57 SENSOR SON SON SON SECONDARY VALUE 59 SECONDARY VALUE 50 SECONDARY VALUE 50 SECONDARY VALUE 51 SENSOR SON SON SON SECONDARY VALUE 51 SENSOR SON SON SON SECONDARY VALUE 55 SECONDARY VALUE 56 SENSOR SON SON SON SECONDARY VALUE 57 SENSOR SON SON SON SON SECONDARY VALUE 59 SECONDARY VALUE 50 SECONDARY VALUE 50 SECONDARY VALUE 50 SECONDARY VALUE 50 SECONDARY VALUE 51 SENSOR SON SON SON SECONDARY VALUE 51 SENSOR SON SON SECONDARY VALUE 51 SENSOR SON SON SECONDARY VALUE 51 SENSOR SON SECONDARY VALUE 51 SENSOR SON SECONDARY VALUE 50 SECONDARY VALUE 50 SECONDARY VALUE 50 SECONDARY VALUE 50 SE		ST REV	2	2		2
3 STRATEGY		_				
4 ALERT, KEY 5 MODE BLK 6 BLOCK ERR 7 UPDATE EVT 8 BLOCK ALM 9 TRANSDUCER, DIRECTORY 10 TRANSDUCER, TYPE 2 2 5 2 11 XD ERROR 11 5 12 COLLECTION, DIRECTORY 13 PRIMARY, VALUE, TYPE 14 PRIMARY, VALUE, TYPE 15 PRIMARY, VALUE, TYPE 16 CAL, POINT, LO 17 CAL, POINT, LO 18 CAL, MIN, SPAN 19 CAL, WITH 18 CAL, WITH 19 CAL, WITH 19 CAL, WITH 20 SENSOR, TYPE 21 SENSOR, SN 41 4 4 22 SENSOR, SN 41 5 SENSOR, CAL, LOC 24 SENSOR, CAL, LOC 25 SENSOR, CAL, LOC 26 SENSOR, CAL, LOC 27 SENSOR, CAL, LOC 28 SENSOR, CAL, LOC 29 SENSOR, CAL, WHO 27 SENSOR, CAL, WHO 27 SENSOR, SN 40 SENSOR, CAL, WHO 28 SENSOR, CAL, WHO 29 SENSOR, SN 40 SENSOR, CAL, WHO 27 SENSOR, SN 41 SENSOR, CAL, WHO 28 SENSOR, CAL, WHO 29 SENSOR, SN 40 SENSOR, CAL, WHO 30 SECONDARY, VALUE, WITH 31 PRESS, LIN, NORMAL 33 PRESS, CUTOFF 34 CUTOFF, FLAG 35 DIGITAL, TEMPERATURE 36 DIFF 37 VPIFF 38 CAPACITANCE, LIOW 49 CAPACITANCE, LIOW 40 BACKUP, RESTORE 41 SENSOR, CALOR 42 COEFF, POL1 44 COEFF, POL2 44 COEFF, POL2 45 CHARLET, SENSOR, CAL 46 COEFF, POL1 47 COEFF, POL5 58 CURVE, Y 59 CURVE, Y 50 COLORY, WALLE, LIN, LIN, LIN, LIN, LIN, LIN, LIN, LIN						2
5						
6 BLOCK ERR 2 2		_	4			
To UPDATE_EVT						
9 TRANSDUCER_DIRECTORY	7					
10	8	BLOCK_ALM				
11	9	TRANSDUCER_DIRECTORY				
12	10	TRANSDUCER_TYPE	2	2	5	2
13	11	XD_ERROR	1			
14						
15				2	5	
16		_	5			
17						11
18				-		
19				4		
20 SENSOR TYPE						
21 SENSOR_RANGE					-	
22 SENSOR_SN					4	
23 SENSOR_CAL_METHOD						
24 SENSOR_CAL_LOC 25 SENSOR_CAL_DATE 26 SENSOR_CAL_MHO 27 SENSOR_SOLATION_MTL 28 SENSOR_SOLATION_MTL 29 SECONDARY_VALUE 30 SECONDARY_VALUE 31 PRESS_LIN_NORMAL 32 PRESS_LIN_NORMAL 33 PRESS_CUTOFF 34 CUTOFF_FLAG 35 DIGITAL_TEMPERATURE 36 DIFF 37 YDIFF 38 CAPACITANCE_LOW 39 CAPACITANCE_HIGH 40 BACKUP_RESTORE 41 SENSOR_RANGE_CODE 42 COEFF_POL0 43 COEFF_POL0 44 COEFF_POL1 45 COEFF_POL3 46 COEFF_POL3 46 COEFF_POL6 47 COEFF_POL6 48 COEFF_POL6 49 COEFF_POL6 40 COEFF_POL6 41 COEFF_POL6 42 COEFF_POL6 43 COEFF_POL6 44 COEFF_POL6 45 COEFF_POL9 46 COEFF_POL9 47 COEFF_POL9 48 COEFF_POL9 49 COEFF_POL9 40 COEFF_POL9 40 COEFF_POL9 41 COEFF_POL9 42 COEFF_POL9 43 COEFF_POL9 44 COEFF_POL9 45 COEFF_POL9 46 COEFF_POL9 47 COEFF_POL9 48 COEFF_POL9 49 COEFF_POL9 40 COEFF_POL9 50 COEFF_POL9 51 COEFF_POL9 52 COEFF_POL9 53 COEFF_POL9 54 COEFF_POL9 55 CHARACTERIZATION_TYPE 56 CURVE_BYPASS_LD 57 CURVE_LENGTH 58 CURVE_Y 59 CURVE_Y 59 CURVE_Y 50 COL_POINT_LO_FACTORY 50 CAL_POINT_LO_FACTORY						
25						l
26 SENSOR_CAL_WHO 27 SENSOR_ISOLATION_MTL 2 28 SENSOR_FLUID 2 29 SECONDARY_VALUE_UNIT 2 30 SECONDARY_VALUE_UNIT 2 31 PRESS_INNORMAL 2 32 PRESS_NORMAL 32 32 PRESS_NORMAL 4 33 PRESS_CUTOFF 4 34 CUTOFF_FLAG 4 35 DIGITAL_TEMPERATURE 4 36 DIFF 4 37 YDIFF 4 38 CAPACITANCE_HIGH 4 40 BACKUP_RESTORE 1 41 SENSOR_RANGE_CODE 2 42 COEFF_POLO 4 43 COEFF_POLO 4 44 COEFF_POLO 4 45 COEFF_POL3 4 46 COEFF_POL4 4 47 COEFF_POL5 4 48 COEFF_POL6 4 4		SENSOR CAL DATE				
27 SENSOR_ISOLATION_MTL 2 28 SENSOR_FLUID 2 29 SECONDARY_VALUE 5 30 SECONDARY_VALUE_UNIT 2 31 PRESS_LIN_NORMAL 31 32 PRESS_NORMAL 32 33 PRESS_CUTOFF 34 34 CUTOFF_FLAG 35 35 DIGITAL_TEMPERATURE 36 36 DIFF 37 38 CAPACITANCE_LOW 39 39 CAPACITANCE_HIGH 40 40 BACKUP_RESTORE 1 41 SENSOR_RANGE_CODE 2 42 COEFF_POL0 4 43 COEFF_POL1 4 44 COEFF_POL2 4 45 COEFF_POL3 4 46 COEFF_POL3 4 47 COEFF_POL5 4 48 COEFF_POL6 4 49 COEFF_POL9 4 51 COEFF_POL9 4 <						
28 SENSOR_FLUID 2 29 SECONDARY_VALUE 5 30 SECONDARY_VALUE_UNIT 2 31 PRESS_LIN_NORMAL 32 32 PRESS_NORMAL 33 33 PRESS_CUTOFF 9 34 CUTOFF_FLAG 9 35 DIGITAL_TEMPERATURE 9 36 DIFF 9 37 YDIFF 9 38 CAPACITANCE_LOW 9 39 CAPACITANCE_HIGH 9 40 BACKUP_RESTORE 1 41 SENSOR_RANGE_CODE 2 42 COEFF_POL0 4 43 COEFF_POL0 4 44 COEFF_POL2 4 45 COEFF_POL3 4 46 COEFF_POL3 4 47 COEFF_POL5 4 48 COEFF_POL6 4 49 COEFF_POL6 4 49 COEFF_POL9 4						2
29						
30			5			
31 PRESS_LIN_NORMAL 32 PRESS_NORMAL 33 PRESS_CUTOFF 34 CUTOFF_FLAG 35 DIGITAL_TEMPERATURE 36 DIFF 37 YDIFF 38 CAPACITANCE_LOW 39 CAPACITANCE_HIGH 40 BACKUP_RESTORE 41 SENSOR_RANGE_CODE 42 COEFF_POL0 43 COEFF_POL1 44 COEFF_POL2 45 COEFF_POL3 46 COEFF_POL5 47 COEFF_POL6 48 COEFF_POL6 49 COEFF_POL6 49 COEFF_POL6 40 COEFF_POL9 40 COEFF_POL6 41 COEFF_POL6 42 COEFF_POL6 43 COEFF_POL6 44 COEFF_POL6 45 COEFF_POL6 46 COEFF_POL6 47 COEFF_POL6 48 COEFF_POL6 49 COEFF_POL6 40 COEFF_POL6 40 COEFF_POL6 40 COEFF_POL6 41 COEFF_POL6 42 COEFF_POL6 43 COEFF_POL6 44 COEFF_POL6 45 COEFF_POL6 46 COEFF_POL6 47 COEFF_POL6 48 COEFF_POL6 49 COEFF_POL6 40 COEFF_POL6 40 COEFF_POL6 41 COEFF_POL6 42 COEFF_POL6 43 COEFF_POL6 44 COEFF_POL6 45 COEFF_POL6 46 COEFF_POL6 47 COEFF_POL6 48 COEFF_POL6 49 COEFF_POL6 40 COEFF_POL6 40 COEFF_POL6 41 COEFF_POL6 42 COEFF_POL6 43 COEFF_POL6 44 COEFF_POL6 44 COEFF_POL6 45 COEFF_POL6 45 COEFF_POL6 46 COEFF_POL6 47 COEFF_POL6 48 COEFF_POL6 49 COEFF_POL6 40 COEFF_POL6				2		
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34 CUTOFF_FLAG 35 DIGITAL_TEMPERATURE 36 DIFF 37 YDIFF 38 CAPACITANCE_LOW 39 CAPACITANCE_HIGH 40 BACKUP_RESTORE 41 SENSOR_RANGE_CODE 42 COEFF_POL0 43 COEFF_POL1 44 COEFF_POL2 45 COEFF_POL3 46 COEFF_POL3 46 COEFF_POL5 47 COEFF_POL5 48 COEFF_POL6 49 COEFF_POL6 49 COEFF_POL9 40 COEFF_POL9 40 COEFF_POL9 41 COEFF_POL9 42 COEFF_POL9 43 COEFF_POL9 44 COEFF_POL5 45 COEFF_POL1 46 COEFF_POL5 47 COEFF_POL5 48 COEFF_POL6 49 COEFF_POL6 40 COEFF_POL7 40 COEFF_POL9 41 COEFF_POL9 42 COEFF_POL9 43 COEFF_POL9 44 COEFF_POL9 45 COEFF_POL9 46 COEFF_POL10 47 COEFF_POL9 48 COEFF_POL10 49 COEFF_POL10 40 COEFF_POL10 41 COEFF_POL10 42 COEFF_POL10 43 COEFF_POL10 44 COEFF_POL10 45 COEFF_POL10 45 COEFF_POL10 46 COEFF_POL10 47 COEFF_POL10 48 COEFF_POL10 49 COEFF_POL10 40 COEFF_POL10 40 COEFF_POL10 41 COEFF_POL10 42 COEFF_POL10 43 COEFF_POL10 44 COEFF_POL10 45 COEFF_POL10 45 COEFF_POL10 46 COEFF_POL10 47 COEFF_POL10 48 COEFF_POL10 49 COEFF_POL10 40 COEFF_POL20 40 COEFF_POL30 40 COEF						
35		CUTOFF_FLAG				
37 YDIFF 38 CAPACITANCE_LOW 39 CAPACITANCE_HIGH 40 BACKUP_RESTORE 41 SENSOR_RANGE_CODE 42 COEFF_POL0 43 COEFF_POL1 44 COEFF_POL2 45 COEFF_POL3 46 COEFF_POL3 47 COEFF_POL5 48 COEFF_POL6 49 COEFF_POL6 49 COEFF_POL8 50 COEFF_POL8 51 COEFF_POL8 52 COEFF_POL1 53 COEFF_POL1 54 COEFF_POL9 55 CHARACTERIZATION_TYPE 56 CURVE_BYPASS_LD 57 CURVE_Y 58 CURVE_Y 59 CURVE_Y 50 CAL_POINT_HI_BACKUP 61 CAL_POINT_HI_BACKUP 61 CAL_POINT_LO_BACKUP 62 CAL_POINT_HI_FACTORY 63 CAL_POINT_LO_FACTORY	35	DIGITAL_TEMPERATURE				
38	36	DIFF				
39	37	YDIFF				
40 BACKUP_RESTORE 41 SENSOR_RANGE_CODE 42 COEFF_POL0 43 COEFF_POL1 44 COEFF_POL2 45 COEFF_POL3 46 COEFF_POL3 47 COEFF_POL5 48 COEFF_POL6 49 COEFF_POL6 49 COEFF_POL8 50 COEFF_POL9 51 COEFF_POL9 52 COEFF_POL9 53 COEFF_POL10 54 POLYNOMIAL_VERSION 55 CHARACTERIZATION_TYPE 56 CURVE_BYPASS_LD 57 CURVE_LENGTH 58 CURVE_Y 59 CURVE_Y 50 CAL_POINT_HI_BACKUP 61 CAL_POINT_HI_FACTORY 63 CAL_POINT_LO_BACKUP 64 CAL_POINT_LO_BACKUP 66 CAL_POINT_LO_FACTORY	38					
41 SENSOR_RANGE_CODE 2 42 COEFF_POL0 4 43 COEFF_POL1 4 44 COEFF_POL2 4 45 COEFF_POL3 4 46 COEFF_POL4 4 47 COEFF_POL5 4 48 COEFF_POL6 4 49 COEFF_POL6 4 50 COEFF_POL8 4 51 COEFF_POL9 4 52 COEFF_POL10 4 53 COEFF_POL10 4 53 COEFF_POL11 4 54 POLYNOMIAL_VERSION 1 55 CHARACTERIZATION_TYPE 1 56 CURVE_BYPASS_LD 2 52 57 CURVE_LENGTH 1 1 58 CURVE_X 20 2 59 CURVE_Y 20 2 60 CAL_POINT_HI_BACKUP 4 4 61 CAL_POINT_HI_FACTORY 4 4 62 CAL_POINT_LO_FACTORY 4 4 </td <td>39</td> <td></td> <td></td> <td></td> <td></td> <td></td>	39					
42 COEFF_POL0 4 43 COEFF_POL1 4 44 COEFF_POL2 4 45 COEFF_POL3 4 46 COEFF_POL4 4 47 COEFF_POL5 4 48 COEFF_POL6 4 49 COEFF_POL7 4 50 COEFF_POL8 4 51 COEFF_POL9 4 52 COEFF_POL9 4 53 COEFF_POL10 4 54 POLYNOMIAL_VERSION 1 55 CHARACTERIZATION_TYPE 1 56 CURVE_BYPASS_LD 2 52 57 CURVE_LENGTH 1 1 58 CURVE_X 20 20 59 CURVE_Y 20 20 60 CAL_POINT_HI_BACKUP 4 4 61 CAL_POINT_HI_FACTORY 4 4 62 CAL_POINT_LO_FACTORY 63 CAL_POINT_LO_FACTORY	40	BACKUP_RESTORE				1
43 COEFF_POL1 4 44 COEFF_POL2 4 45 COEFF_POL3 4 46 COEFF_POL4 4 47 COEFF_POL5 4 48 COEFF_POL6 4 49 COEFF_POL7 4 50 COEFF_POL8 4 51 COEFF_POL9 4 52 COEFF_POL10 4 53 COEFF_POL11 4 54 POLYNOMIAL_VERSION 1 55 CHARACTERIZATION_TYPE 1 56 CURVE_BYPASS_LD 2 52 57 CURVE_LENGTH 1 1 58 CURVE_X 20 60 CAL_POINT_HI_BACKUP 4 61 CAL_POINT_LO_BACKUP 4 62 CAL_POINT_HI_FACTORY 4						2
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45 COEFF_POL3 4 46 COEFF_POL4 4 47 COEFF_POL5 4 48 COEFF_POL6 4 49 COEFF_POL7 4 50 COEFF_POL8 4 51 COEFF_POL9 4 52 COEFF_POL10 4 53 COEFF_POL11 4 54 POLYNOMIAL_VERSION 1 55 CHARACTERIZATION_TYPE 1 56 CURVE_BYPASS_LD 2 52 57 CURVE_LENGTH 1 1 58 CURVE_X 20 20 59 CURVE_Y 20 20 60 CAL_POINT_HI_BACKUP 4 4 61 CAL_POINT_LO_BACKUP 4 4 62 CAL_POINT_HI_FACTORY 63 CAL_POINT_LO_FACTORY		_				
46 COEFF_POL4 4 47 COEFF_POL5 4 48 COEFF_POL6 4 49 COEFF_POL7 4 50 COEFF_POL8 4 51 COEFF_POL9 4 52 COEFF_POL10 4 53 COEFF_POL11 4 54 POLYNOMIAL_VERSION 1 55 CHARACTERIZATION_TYPE 1 56 CURVE_BYPASS_LD 2 52 57 CURVE_LENGTH 1 1 58 CURVE_X 20 20 59 CURVE_Y 20 20 60 CAL_POINT_HI_BACKUP 4 4 61 CAL_POINT_LO_BACKUP 4 4 62 CAL_POINT_HI_FACTORY 63 CAL_POINT_LO_FACTORY						
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48 COEFF_POL6 4 49 COEFF_POL7 4 50 COEFF_POL8 4 51 COEFF_POL9 4 52 COEFF_POL10 4 53 COEFF_POL11 4 54 POLYNOMIAL_VERSION 1 55 CHARACTERIZATION_TYPE 1 56 CURVE_BYPASS_LD 2 52 57 CURVE_LENGTH 1 1 58 CURVE_X 20 20 59 CURVE_Y 20 20 60 CAL_POINT_HI_BACKUP 4 4 61 CAL_POINT_LO_BACKUP 4 4 62 CAL_POINT_HI_FACTORY 63 CAL_POINT_LO_FACTORY						
49 COEFF_POL7 4 50 COEFF_POL8 4 51 COEFF_POL9 4 52 COEFF_POL10 4 53 COEFF_POL11 4 54 POLYNOMIAL_VERSION 1 55 CHARACTERIZATION_TYPE 1 56 CURVE_BYPASS_LD 2 52 57 CURVE_LENGTH 1 58 CURVE_X 20 59 CURVE_Y 20 60 CAL_POINT_HI_BACKUP 4 61 CAL_POINT_LO_BACKUP 4 62 CAL_POINT_HI_FACTORY 4 63 CAL_POINT_LO_FACTORY						
50 COEFF_POL8 4 51 COEFF_POL9 4 52 COEFF_POL10 4 53 COEFF_POL11 4 54 POLYNOMIAL_VERSION 1 55 CHARACTERIZATION_TYPE 1 56 CURVE_BYPASS_LD 2 52 57 CURVE_LENGTH 1 58 CURVE_X 20 59 CURVE_Y 20 60 CAL_POINT_HI_BACKUP 4 61 CAL_POINT_LO_BACKUP 4 62 CAL_POINT_HI_FACTORY 4 63 CAL_POINT_LO_FACTORY 63		_				
51 COEFF_POL9 4 52 COEFF_POL10 4 53 COEFF_POL11 4 54 POLYNOMIAL_VERSION 1 55 CHARACTERIZATION_TYPE 1 56 CURVE_BYPASS_LD 2 52 57 CURVE_LENGTH 1 58 CURVE_X 20 59 CURVE_Y 20 60 CAL_POINT_HI_BACKUP 4 61 CAL_POINT_LO_BACKUP 4 62 CAL_POINT_HI_FACTORY 4 63 CAL_POINT_LO_FACTORY 63		_				
52 COEFF_POL10 4 53 COEFF_POL11 4 54 POLYNOMIAL_VERSION 1 55 CHARACTERIZATION_TYPE 1 56 CURVE_BYPASS_LD 2 52 57 CURVE_LENGTH 1 58 CURVE_X 20 59 CURVE_Y 20 60 CAL_POINT_HI_BACKUP 4 61 CAL_POINT_LO_BACKUP 4 62 CAL_POINT_HI_FACTORY 63 CAL_POINT_LO_FACTORY		_				
53 COEFF_POL11 4 54 POLYNOMIAL_VERSION 1 55 CHARACTERIZATION_TYPE 1 56 CURVE_BYPASS_LD 2 52 57 CURVE_LENGTH 1 1 58 CURVE_X 20 20 59 CURVE_Y 20 20 60 CAL_POINT_HI_BACKUP 4 4 61 CAL_POINT_LO_BACKUP 4 4 62 CAL_POINT_HI_FACTORY 63 CAL_POINT_LO_FACTORY						-
54 POLYNOMIAL_VERSION 1 55 CHARACTERIZATION_TYPE 1 56 CURVE_BYPASS_LD 2 52 57 CURVE_LENGTH 1 1 58 CURVE_X 20 2 59 CURVE_Y 20 2 60 CAL_POINT_HI_BACKUP 4 4 61 CAL_POINT_LO_BACKUP 4 4 62 CAL_POINT_HI_FACTORY 63 CAL_POINT_LO_FACTORY		_				
55 CHARACTERIZATION_TYPE 1 56 CURVE_BYPASS_LD 2 52 57 CURVE_LENGTH 1 1 58 CURVE_X 20 2 59 CURVE_Y 20 2 60 CAL_POINT_HI_BACKUP 4 4 61 CAL_POINT_LO_BACKUP 4 4 62 CAL_POINT_HI_FACTORY 63 CAL_POINT_LO_FACTORY		- · · - · · · · · · · · · · · · · · · ·				
56 CURVE_BYPASS_LD 2 52 57 CURVE_LENGTH 1 58 CURVE_X 20 59 CURVE_Y 20 60 CAL_POINT_HI_BACKUP 4 61 CAL_POINT_LO_BACKUP 4 62 CAL_POINT_HI_FACTORY 63 63 CAL_POINT_LO_FACTORY 63				1		'
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58 CURVE_X 20 59 CURVE_Y 20 60 CAL_POINT_HI_BACKUP 4 61 CAL_POINT_LO_BACKUP 4 62 CAL_POINT_HI_FACTORY 4 63 CAL_POINT_LO_FACTORY 4					<u> </u>	
59 CURVE_Y 20 60 CAL_POINT_HI_BACKUP 4 61 CAL_POINT_LO_BACKUP 4 62 CAL_POINT_HI_FACTORY 63 63 CAL_POINT_LO_FACTORY 63		_		_		
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61 CAL_POINT_LO_ BACKUP 4 62 CAL_POINT_HI_FACTORY 63 CAL_POINT_LO_FACTORY						
62 CAL_POINT_HI_FACTORY 63 CAL_POINT_LO_FACTORY				4		
63 CAL_POINT_LO_FACTORY						
64 CAL_TEMPERATURE	63					
	64	CAL_TEMPERATURE				

Relative Index	Parameter Mnemonic	View_1	View_2	View_3	View_4
65	DATASHEET				
66	ORDERING CODE				
67	MAXIMUM_MEASURED_PRESSURE				
68	MAXIMUM_MEASURED_TEMPERATURE				
69	ACTUAL OFFSET				
70	ACTUAL_SPAN				
71	MAXIMUM_OFFSET_DEVIATION				
72	MAXIMUM_GAIN_DEVIATION				
73	OVERPRESSURE LIMIT				
74	MAXIMUM_NUMBER_OF_OVERPRESSURE				
75	GRAVITY				
76	HEIGHT				
77	MEASURED TYPE				
78	LIN_DILATATION_COEF				
79	PRESSURE_COEFFICIENT				
80	ZERO ADJUST TEMP				
81	HEIGHT_MEAS_TEMP				
82	TEMP_ZERO				
83	TEMP_GAIN				
84	AUTO_CAL_POINT_LO				
85	AUTO_CAL_POINT_HI				
86	SOLID_POL_COEFF_0				
87	SOLID_POL_COEFF_1				
88	SOLID_POL_COEFF_2				
89	SOLID_POL_COEFF_3				
90	SOLID_POL_COEFF_4				
91	SOLID_POL_COEFF_5				
92	SOLID_LIMIT_LO				
93	SOLID_LIMIT_HI				
94	PRESS_COMP				
95	SIMULATE_PRESS_ENABLE				
96	SIMULATE_PRESS_VALUE				
97	SIMULATE_DENSITY_VALUE				
98	CALCULATED_PRESS_VALUE				
99	CALC_PRESS_CAL_POINT_LO				
100	CALC_PRESS_CAL_POINT_HI				
101	DT_RANGE_CODE				
102	DENSITY_KGM3				
103	DENSITY_STATUS				
104	CONC				
105	HI_LIM_DENS				
106	LO_LIM_DENS				
107	HI_LIM_TEMP				
108	LO_LIM_TEMP				
109	K_DENS				
110 111	K_TEMP MOUNTING_POSITION				
111	TOTAL	21 bytes	60 hutes	E2 bytes	00 bytes
	TOTAL	ZI Dytes	บอ มูงเฮร	52 bytes	ฮฮ มyเซร

Table 3.3 Concentration/Density Transducer Block View Object

How to Configure the Transducer Block

The transducer block has an algorithm, a set of contained parameters and a channel connecting it to a function block.

The algorithm describes the behavior of the transducer as a data transfer function between the I/O hardware and other function block. The set of contained parameters, it means, you are not able to link them to other blocks and publish the link via communication, defines the user interface to the transducer block. They can be divided into Standard and Manufacturer Specific.

The standard parameters will be present for such class of device, as density, pressure, temperature, actuator, etc., whatever is the manufacturer. Oppositely, the manufacturers' specific ones are defined only for its manufacturer. As common manufacturer specific parameters, we have calibration settings, material information, linearization curve, etc.

When you perform a standard routine as a calibration, you are conducted step by step by a method. The method is generally defined as guide line to help the user to make common tasks. The configuration tool identifies each method associated to the parameters and enables the interface to it. The Syscon (System Configurator) configuration software from Smar, for example, can configure many parameters of the blocks.

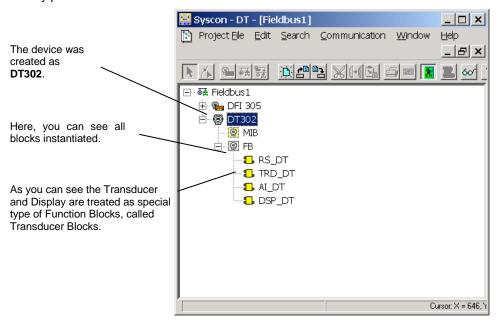


Figure 3.2 - Function and Transducers Blocks

To make the configuration of Transducer Block, we need to select this block and right click with the mouse to choose 'On Line Configuration'.

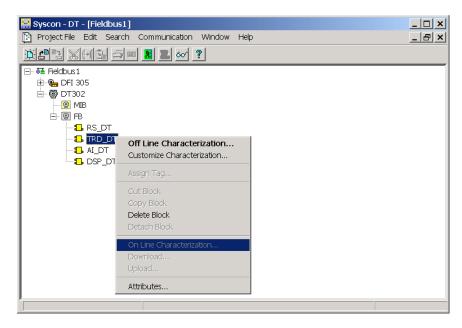


Figure 3.3 - Online Configuration – Transducer

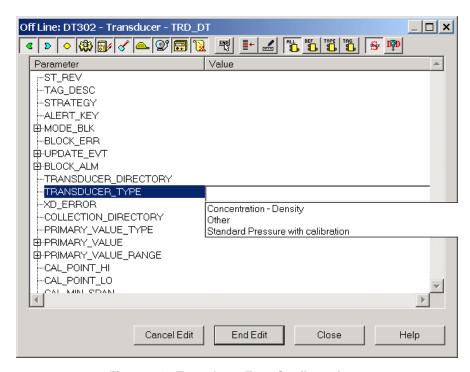


Figure 3.4 - Transducer Type Configuration

Using this window, the user can set the transducer type according to the application, selecting "Density".

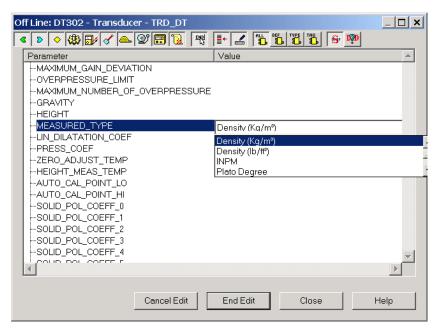


Figure 3.5 - Measured Type Configuration

Also, the user can select the Measured Type, choosing Density (g/cm³), Density (Kg/m³), Relative Density @ 20° C (g/cm³), Relative Density @ 4° C (g/cm³), Baumé, Brix, Plato Degree, INPM, Relative Density Alcohol 0 - 100, Solid Percent, Density (lb/ft³) and API.

Engineering Unit Selection

The user can also choose the Measured_Type:

- Density (g/cm³)
- Density (Kg/m³)
- Relative Density @ 20°C
- Relative Density @ 4°C
- Generic Concentration
- Baume
- Brix
- Plato Degree
- INPM
- GL
- Solid Percent
- Density (lb/ft³)
- API.

Solid Percent (% sol)

The concentration/ density transmitter **DT302** offers resources with the objective of relating Baume degree to solid percent.

The general equation to determine the solid percent is:

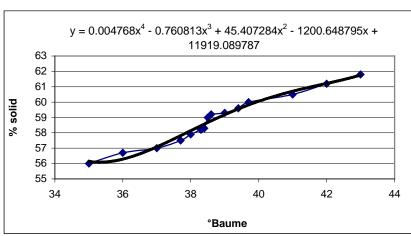
%sol = a0 + a1 bme1 + a2 bme2 + a3 bme3 + a4bme4 + a5 bme5

The table and the graph below indicate the application of the **DT302** polynomial that relates Baume degree to solid percent, generating the polynomial:

y = 0.004768x4 - 0.760813x3 + 45.407284x2 - 1200.648795x + 11919.089787.

	X	Υ
1	Bme	%SOL.
2	35	56
3	36	56,7
4	37	57
5	37,7	57,5
6	38	57,9
7	38,3	58,2
8	38,4	58,3
9	38,5	59
10	38,6	59,2
11	39	59,3
12	39,4	59,6
13	39,7	60
14	41	60,5
15	42	61,2
16	43	61,8

POLYNOMIAL REGRESSION



Generic Concentration Percentage (% conc)

For applications that demand other relation among measures, the polynomial used is:

$$f(a,d,t) = a_0 + a_1 d + a_2 d^2 + a_3 d^3 + a d^4 + a_5 d^5 + a_6 d t + a_7 d^2 t + a_8 d^3 t + a_9 d t^2 + a_{10} d t^3 + a_{11} d^2 t^2 + a_{12} d^3 t^3 + a_{13} t + a_{14} t^2 + a_{15} t^3 + a_{16} t^4 + a_{17} t^5$$

This function is applied to a higher number of applications. It relates three measurements: density, temperature and concentration.

As the digital display used in DT301 is of $4 \frac{1}{2}$ digits, the maximum indicated value would be 19999. When selecting the unit, be certified that in your application the value won't surpass 19999.

WARNING

The XD_SCALE from transducer block should follow the measured type unit and its range; otherwise an error is going to appear in the XD_ERROR.

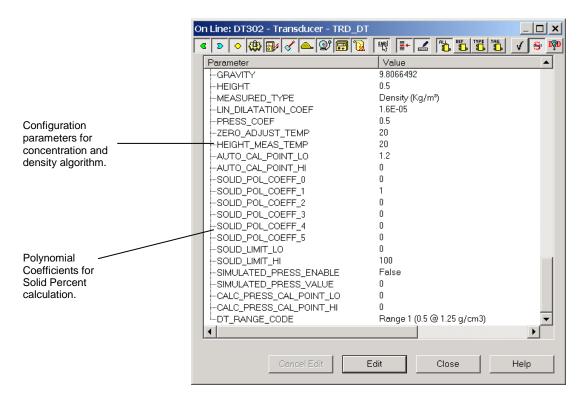


Figure 3.6 – Density Parameters

AI XD_SCALE.unit for Concentration/Density							
Mossured Type	Ra	nge 1	Range 2		Range 3		Al Unit
Measured Type	Lower	Upper	Lower	Upper	Lower	Upper	
Density (g/cm³)	0.445	1.98	0.9	2.75	2.25	5.5	g/cm³
Density (Kg/m³)	445.0	1980.0	900.0	2750.0	2250.0	5500.0	Kg/m³
Density (lb/ft³)	27.9	124.3	55.8	171.6	140.4	343.2	lb/ft ³
Relative Density @ 20°C (g/cm³)	0.445	1.98	0.9	2.75	2.25	5.5	Kg/m³
Relative Density @ 4°C (g/cm³)	0.445	1.98	0.9	2.75	2.25	5.5	Kg/m³
Baume	-5.2	57.2	-	-	-	-	degBaum
Brix	-10.0	110.0	-	-	-	-	degBrix
Plato Degree	-10.0	110.0	-	-	-	-	%Plato
INPM	-10.0	110.0	-	-	-	-	INPM
Relative Density Alcohol 0 100	-10.0	110.0	-	-	-	-	Alcohol 0 100
Solid Percent	-10.0	55.0	-	-	-	-	%Soli/wt

How to Configure the Analog Input Block

The Analog Input block takes the input data from the Transducer block, selected by channel number, and makes it available to other function blocks at its output. When the Measured Type is changed in the transducer block, the unit and the range of XD_SCALE must be changed too. Optionally, a filter may be applied in the process value signal, whose time constant is PV_FTIME. Considering a step change to the input, this is the time in seconds to the PV reaches 63.2 % of the final value. If the PV_FTIME value is zero, the filter is disabled. For more details, please, see the Function Blocks Specifications.

To configure the Analog Input Block in offline mode, please, go to the main menu and select "Device Offline Configuration - Analog Input Block. Using this window, the user can configure the block mode operation, selects the channel, scales and unit for input and output value and the damping.

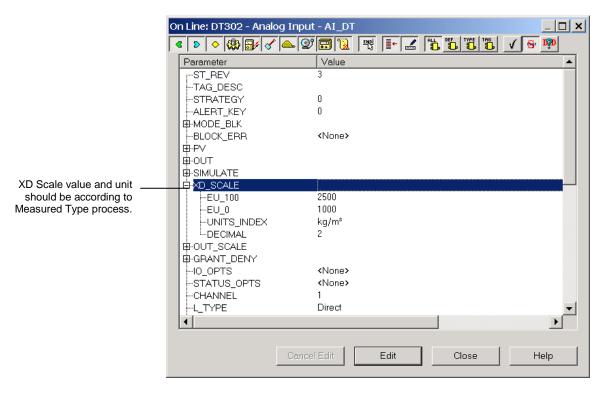


Figure 3.7 – AI Block – XD_SCALE Configuration

Lower and Upper Concentration/ Density Calibration

Each sensor has a characteristic curve that establishes a relation between the applied pressure, the sensor signal and the measured concentration/density. This curve is determined for each sensor and it is stored in a memory together with the sensor. When the sensor is connected to the transmitter circuit, the content of its memory is made available to the microprocessor.

Sometimes the value on the transmitter display and transducer block reading may not match the applied pressure.

The reasons may be:

- The transmitter mounting position.
- The user's pressure standard differs from the factory standard.
- The transmitter had its original characterization shifted by over pressurization, over heating or by long term drift.

The calibration is used to match the reading with the correct concentration/density.

Please, sure that the **DT302** is measuring concentration/density. Open the Transducer Block and see the Transducer Type parameter. Please, see the following figure:

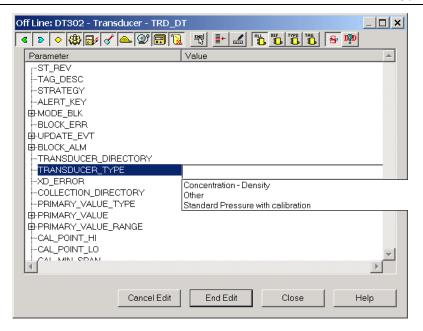


Figure 3.8 – Transducer Block – Transducer Type Selection

If is required an adjustment of unit, please just select the desired unit using the measured type parameter according to the application. If the adjust requires a changing of measured values, please, calibrate the device with reference, according to these steps:

- Wait the process stabilizes and collect a sample;
- Determine in laboratory the value of density/concentration of stabilized process.

Using the **Syscon** (or any configuration tool), the user can select the measured type and the lower and upper calibration procedure.

If the user selects lower or upper page, the following window is shown and the user can see the actual calibrated point, the primary value and status and the result of calibration procedure:

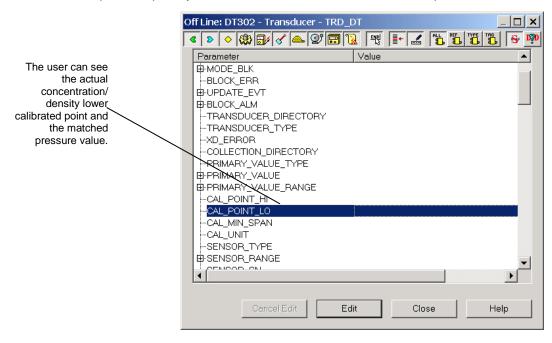


Figure 3.9 - Concentration / Density Calibration

The calibrated point must be inside of the sensor range limits allowed for each type of concentration/density measuring.

Lower and Upper Concentration/ Density Self-Calibration

With the self-calibration is possible to make a device precise calibration. In this procedure the air density is used as reference (in Kg/m³) and water concentration (in BRIX). These references are used because it is easy to have it on the field.

Lower Calibration (Air Self-Calibration)

Place the **DT302** in work position (vertical) and facing the air, wait approximately **5** minutes for stabilization. To execute the lower calibration, write a value to AUTO_CAL_POINT_LO. Any value written will calibrate internally the transmitter in 1.2 Kg/m³. Notice that the MEASURED_TYPE parameter should be configured to Density (Kg/m³).

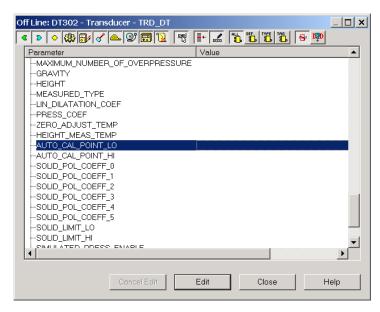


Figure 3.10 - Lower Concentration / Density Self-Calibration

Upper Calibration (Water Self-Calibration)

After air calibration, place the **DT302** in work position (vertical) and in water, immersing both diaphragms, wait approximately **5** minutes for stabilization and then writes a value to AUTO_CAL_POINT_HI. Any value written will calibrate internally the transmitter in 0.0 BRIX. Notice that the MEASURED_TYPE parameter should be configured to BRIX.

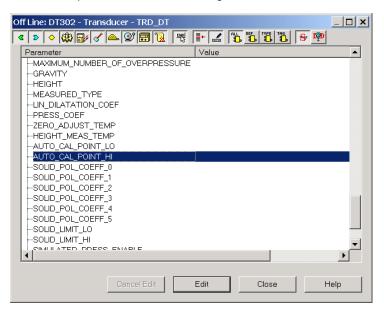


Figure 3.11 – Upper Concentration / Density Self-Calibration

Via Local Adjustment

Concentration/Density Calibration

The calibration process is always with reference, it means that the user must apply to the transmitter the measuring conditions. In order to calibrate via local adjustment, firstly is necessary to configure the TRDTY, LOWER and UPPER in the Display Function Block. For details, please see the section 'Display Transducer Block'.

Please, see the resumed table for the transducer parameters involved in the calibration process:

Parameter (Name)	Parameter (Relative Index)	Item (Element)	Mnemonic
TRANSDUCER_TYPE	10	-	TRDTY
CAL_POINT_LO	17	-	LO
CAL_POINT_HI	16	-	HI

The adjustment is done following these steps:

- Wait the process stabilizes and collect a sample;
- Determine in laboratory the value of density/concentration of stabilized process;
- In order to enter the local adjustment mode, place the magnetic tool in the orifice "Z" until flag "MD" lights up in the display. Remove the magnetic tool from "Z" and place it in the orifice "S". Remove and reinsert the magnetic tool in "S" until the message "LOC ADJ" is displayed. The message will be displayed during approximately 5 seconds after removing the magnetic tool from "S". Insert the magnetic tool in "Z" and browse up to the TRDTY parameter to select the Transducer Type to "Density". Then, browse up to the LOWER or UPPER to make the calibration process, informing the determined value for the collected sample, for example, if the density is 1000 Kg/m³, then with the magnetic tool in the orifice "S", write for example, in UPPER parameter this value and remove the magnetic tool. After returning to monitoring, the Primary Value will indicate the calibrated value for this stabilized condition.

The calibration process procedure for LOWER and UPPER is identical. It is only necessary to inform the concentration/density for the collected sample.

Limit Conditions for Concentration / Density Calibration:

For every writing operation in the transducer blocks there is an indication for the operation associate with the writing method. These codes appear in parameter XD_ERROR. Every time a calibration is performed. Code 16, for example, indicates a successfully performed operation.

Limits for Concentration/Density Calibration								
Magazirod Typo	Rai	Range 1		ge 2	Range 3			
Measured Type	Lower	Upper	Lower	Upper	Lower	Upper		
Density (g/cm³)	0.445	1.98	0.9	2.75	2.25	5.5		
Density (Kg/m³)	445.0	1980.0	900.0	2750.0	2250.0	5500.0		
Density (lb/ft³)	27.9	124.3	55.8	171.6	140.4	343.2		
Relative Density @ 20°C (g/cm³)	0.445	1.98	0.9	2.75	2.25	5.5		
Relative Density @ 4°C (g/cm³)	0.445	1.98	0.9	2.75	2.25	5.5		
Baume	-5.2	57.2	-	-	-	-		
Brix	-10.0	110.0	-	-	-	-		
Plato Degree	-10.0	110.0	-	-	-	-		
INPM	-10.0	110.0	-	-	-	-		
Relative Density Alcohol 0 100	-10.0	110.0	-	-	-	-		
Solid Percent	-10.0	55.0	-	-	-	-		

Notes: 1. Reference value @ 20°C 2. Over range limits +/- 10%

Limit Conditions for Pressure Calibration:

For every writing operation in the transducer blocks there is an indication for the operation associate with the writing method. These codes appear in parameter XD_ERROR. Every time a calibration is performed. Code 16, for example, indicates a successfully performed operation.

Upper:

SENSOR_RANGE_EUO < NEW_UPPER < SENSOR_HI_LIMIT * 1.25 Otherwise, Invalid calibration request. (NEW_UPPER - TRIMMED_VALUE) < SENSOR_HI_LIMIT * 0.1 Otherwise, Excessive correction. (NEW_UPPER - CAL_POINT_LO) > CAL_MIN_SPAN * 0,75 Otherwise, Invalid calibration request.

Lower:

SENSOR_RANGE.EU0 < NEW_LOWER < SENSOR_HI_LIMIT * 1.25
Otherwise, Invalid calibration request
SENSOR_LO_LIMIT < TRIMMED _VALUE < SENSOR_HI_LIMIT * 1.25
Otherwise, Out of range.
NEW_LOWER - TRIMMED _VALUE | < SENSOR_HI_LIMIT * 0.1
Otherwise, Excessive correction.
CAL_POINT_HI - NEW_LOWER | > CAL_MIN_SPAN * 0.75
Otherwise, Invalid calibration request.

If all limit conditions are according to these rules, the operation will be well succeeded.

NOTE
Codes for XD_ERROR:
16: Default Value Set
22: Out of Range
26: Invalid Calibration Request
27: Excessive Correction.

Self-Calibration

In order to make the self-calibration using the local adjustment, firstly is necessary to configure the AUTO_CAL_POINT_LO (LO) and AUTO_CAL_POINT_HI (HI) into the Display Function Block. For details, please see the section 'Display Transducer Block'.

Please, see the resumed table for the transducer parameters involved in the calibration process:

Parameter (Name)	Parameter(Relative Index)	Item(Element)	Mnemonic
TRANSDUCER_TYPE	10		TRDTY
MEASURED_TYPE	77		MEAST
AUTO_CAL_POINT_LO	84		LO
AUTO CAL POINT HI	85		HI

To execute the Lower calibration, firstly the user should apply air to the sensors and then using the magnetic tool browses up to LO parameter and only writes a value. Any value written will calibrate internally the transmitter in $0.00 \text{ mmH}_2\text{O}$.

To execute the Upper calibration, firstly the user should insert the sensors in water and then using the magnetic tool browses up to HI parameter and only writes a value. In this situation, the applied pressure will be according to the distance between the sensors and the local gravity (500.0 mmH_2O).

Temperature Calibration

Write in parameter CAL_TEMPERATURE any value in the range -10°C to +120°C. After that, check the calibration performance using parameter SECONDARY_VALUE.

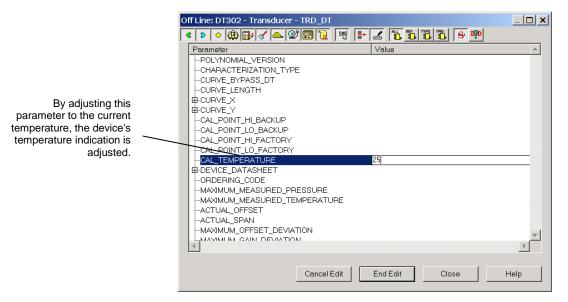


Figure 3.12 - Temperature Calibration Configuration Screen

Sensor Data Reading

Always when **DT302** is on, is verified if the serial number of the sensor in the sensor board is the same that the saved serial number in EEPROM in the main board. When these numbers are different (a swap of sensor set or main board was carried through) the data stored in the EEPROM of sensor board is copied to the EEPROM of the main board.

Through the parameter BACKUP_RESTORE, also this reading can be made, choosing the option "Sensor Data Restore". The operation, in this case, is made independent of the sensor serial number. Through the option "Sensor Data Backup", the sensor data stored in the main board EEPROM memory can be saved in the EEPROM of the sensor board. (This operation is done at factory).

Through this parameter, we can recover default data from factory about sensor and last saved calibration settings, as well as making the rescue of calibrations. We have the following options:

Factory Cal Restore: Recover last calibration settings made at factory;

• Last Cal Restore: Recover last calibration settings made by user and saved as backup;

• Default Data Restore: Restore all data as default:

• Sensor Data Restore: Restore sensor data saved in the sensor board and copy them to

main board EEPROM memory.

Factory Cal Backup: Copy the actual calibration settings to the factory ones;
 Last Cal Backup: Copy the actual calibration settings to the backup ones;

• Sensor Data Backup: Copy the sensor data at main board EEPROM memory to the

EEPROM memory located at the sensor board;

None: Default value, no action is done.

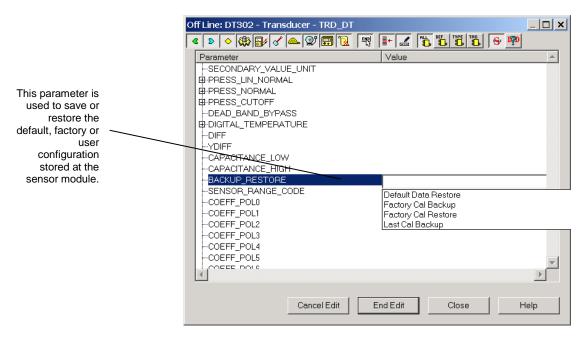


Figure 3.13 - Backup Restore Option

Transducer Display - Configuration

Using the Syscon or any other configuration tool is possible to configure the Display Transducer block. As the name described it is a transducer due the interfacing of its block with the LCD hardware.

The Transducer Display is treated as a normal block by any configuration tool. It means, this block has some parameters and those ones can be configured according to customer's needs.

The customer can choose up to seven parameters to be shown at LCD display; they can be parameters just for monitoring purpose or for acting locally in the field devices by using a magnetic tool. The first two parameters will be toggle in the display.

Display Transducer Block

The local adjustment is completely configured by SYSCON or any configuration tool. It means, the user can select the best options to fit his application. From factory, it is configured with the options to set the Upper and Lower trim, for monitoring the input transducer output and check the Tag. Normally, the transmitter is much better configured by SYSCON, but the local functionality of the LCD permits an easy and fast action on certain parameters, since it does not rely on communication and network wiring connections. Among the possibilities by Local Adjustment, the following options can be emphasized: Mode block, Outputs monitoring, Tag visualization and Tuning Parameters setting.

The interface with the user is described very detailed on the "General Installation, Operation and Maintenance Procedures Manual". Please take a detailed look at this manual in the chapter related to "Programming Using Local Adjustment". It is significantly the resources on this transducer display, also all the Series 302 field devices from Smar has the same methodology to handle with it. So, since the user has learned once, he is capable to handle all kind of field devices from Smar.

All functions blocks and transducers defined according Profibus PA have a description of their features written, by the Device Description Language. This feature permits that third party configuration tools enabled by Device Description Service technology can interpret these features and make them accessible to configure. The Function Blocks and Transducers of Series 302 have been defined rigorously according the Foundation Fieldbus specifications in order to be interoperable to other parties.

In order to work with the local adjustment using the magnetic tool, it is necessary to previously prepare the parameters related with this operation via SYSCON (System Configuration).

There are seven groups of parameters, which may be pre-configured by the user in order to able, a possible configuration by means of the local adjustment. As an example, let's suppose that you don't want to show some parameters; in this case, simply write an invalid Tag in the parameter Block_Tag_Param_X. Doing this, the device will not take the parameters related (indexed) to its Block as a valid parameter.

Definition of Parameters and Values

Block_Tag_Param

This is tag of the block to which the parameter belongs. Use up to a maximum of 32 characters.

Index Relative

This is the index related to the parameter to be actuated or viewed (0, 1, 2...). Refer to the Function Blocks Manual to know the desired indexes, or visualize them on the **SYSCON** opening the desired block.

Sub Index

In case you want to visualize a certain tag, opt for the index relative equal to zero, and for the sub-index equal to one (refer to paragraph Structure Block in the Function Blocks Manual).

Mnemonic

This is the mnemonic for the parameter identification (it accepts a maximum of 16 characters in the alphanumeric field of the display). Choose the mnemonic, preferably with no more than 5 characters because, this way, it will not be necessary to rotate it on the display.

Inc Dec

It is the increment and decrement in decimal units when the parameter is Float or Float Status type, or integer, when the parameter is an integer type.

Decimal_Point_Numb

This is the number of digits after the decimal point (0 to 3 decimal digits).

Access

The access allows the user to read, in the case of the "Monitoring" option, and to write when "Action" option is selected, then the display will show the increment and decrement arrows.

Alpha_Num

These parameters include two options: value and mnemonic. In option value, it is possible to display data both in the alphanumeric and in the numeric fields; this way, in the case of a data higher than 10000, it will be shown in the alphanumeric field. In option mnemonic, the display may show the data in the numeric field and the mnemonic in the alphanumeric field.

This parameter allows switching up to 6 parameters on the LCD during the monitoring.

In case you wish to visualize a certain tag, opt for the index relative equal to zero, and for the sub-index equal to one (refer to paragraph Structure Block in the Function Blocks Manual).

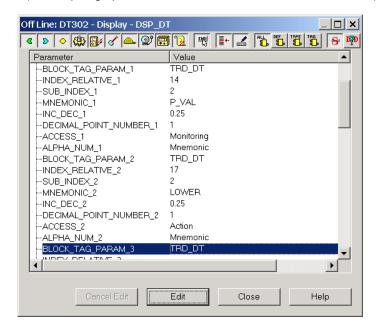


Figure 3.14 - Parameters for Local Adjustment Configuration

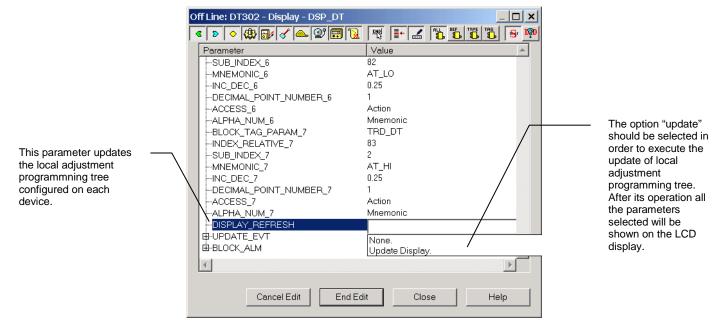


Figure 3.15 – Parameters for Local Adjustment Configuration

Calibrating Using Local Adjustment

In order to follow the example bellow the Display Transducer block should be configured to show these parameters: CAL_POINT_HI (mnemonic UPPER), CAL_POINT_LO (mnemonic LOWER) and TAG (mnemonic TAG).

The transmitter has two holes for magnetic switches, located under the identification plate. These magnetic switches are activated by one magnetic tool.

This magnetic tool enables adjustment of the most important parameters of the blocks. It also enables pre-configuration of the communication.

The jumper w1 on top of the main circuit board must be in place and the transmitter must be fitted with the digital display for access to the local adjustment. Without the display the local adjustment is not possible.

In order to enter the local adjustment mode, place the magnetic tool in orifice "Z" until flag "MD" lights up in the display. Removes magnetic tool from "Z" and place it in orifice "S". Remove and reinsert the magnetic tool in "S" until the message "LOC ADJ" is displayed.

The message will be displayed during approximately 5 seconds after the user removes the magnetic tool from "S". By placing the magnetic tool in "Z" the user will be able to access the local adjustment/monitoring tree.

The jumper W1 on top of the main circuit board must be in place and the transmitter must be fitted with digital display for access to the local adjustment. Without display, the local adjustment is not possible.

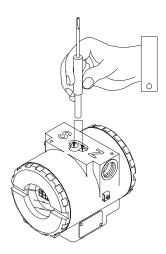


Figure 3.16 - Local Adjustment

Table 3.4 shows the actions on the **Z** and **S** holes on the **DT302** when Local Adjustment is enabled.

HOLE	ACTION			
Z	Initializes and rotates through the available functions.			
S	Selects the function shown in the display.			

Table 3.4 - Purpose of the holes on the Housing

J1 Jumper Connections

If J1 (see figure 3.21) is connected to ON, then simulation mode in the AI block is enabled.

W1 Jumper Connections

If W1 (see figure 3.21) is connected to ON, the local adjustment programming tree is enabled and then important block parameters can be adjusted and communication can be pre-configured via local adjustment.

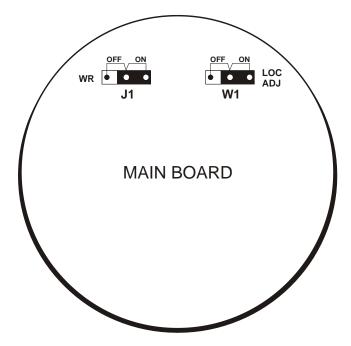


Figure 3.17 - J1 and W1 Jumpers

In order to start the local adjustment, place the magnetic tool in orifice Z and wait until letters MD are displayed.

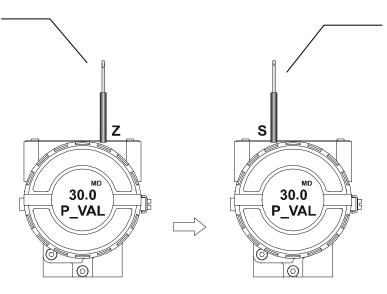
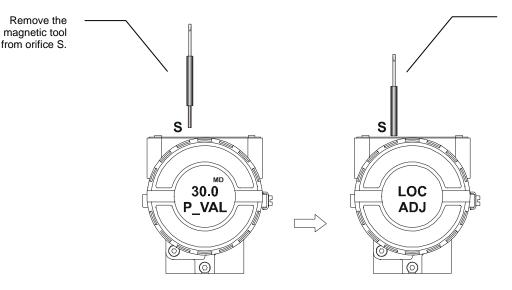


Figure 3.18 - Step 1 - DT302

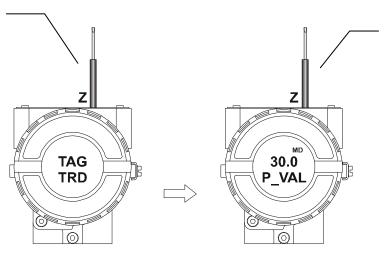
Place the magnetic tool in orifice S and wait for 5 seconds.



Insert the magnetic tool in orifice S and once more LOC ADJ should be displayed.

Figure 3.19 - Step 2 - DT302

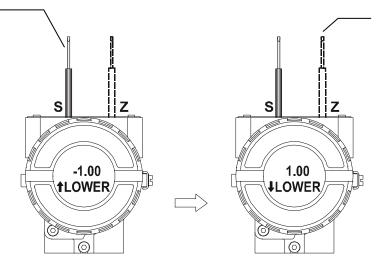
Place the magnetic tool in orifice Z. If this is the first configuration, the option shown on the display is the TAG with its corresponding mnemonic configured by the SYSCON. Otherwise, the option shown on the display will be the one configured in the prior operation. By keeping the tool inserted in this orifice, the local adjustment menu will rotate.



In this option the first variable (P_VAL) is showed with its respective value. If it is wanted it to be static, place the tool in S and keep it there.

Figure 3.20 - Step 3 - DT302

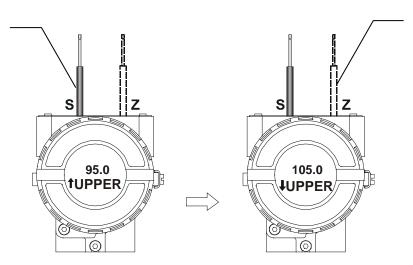
In order to calibrate the lower value (LOWER), insert the magnetic tool in orifice S as soon as LOWER is shown in the display. An arrow pointing upward (↑) increments the value and an arrow pointing downward (↓) decrements the value. In order to increment the value, keep the tool inserted in S until the desired value is set.



In order to decrement the lower value, place the magnetic tool in orifice Z to shift the arrow to the downward position and then, by inserting and keeping the tool in orifice S, it is possible to decrement the lower value.

Figure 3.21 - Step 4 - DT302

In order to calibrate the upper value (UPPER), insert the magnetic tool in orifice S as soon as upper is shown in the display. An arrow pointing upward (↑) increments the valve and an arrow pointing downward (↓) decrements the value. In order to increment the value, keep the tool inserted in S until the desired value is set.



the upper value, place the magnetic tool in orifice Z to shift the arrow to the downward position and then; by insetting and keeping the tool in orifice S, it is possible to decrement the upper value.

In order to decrement

Figure 3.22 - Step 5 - DT302

MAINTENANCE PROCEDURES

General

DT302 Concentration/ Density transmitters are extensively tested and inspected before delivery to the end user. Nevertheless, during their design and development, consideration was given to the possibility of repairs by the end user, if necessary.

In general, it is recommended that end users do not try to repair printed circuit boards. Spare circuit boards may be ordered from Smar whenever necessary.

The **DT302** has been designed to operate for many years without malfunctions. The process application can require periodic cleaning of the repeater diaphragms, and then the flanges may be easily removed and reinstalled. The transmitter eventually can require maintenance, and then it may be changed in the field. In this case, the possibly damaged sensor should be returned to Smar for evaluation and, if necessary, repair. Refer to the item "Returning Materials" at the end of this Section. The table 4.1 shows the symptoms and the probable source of problem cause:

SYMPTOM	PROBABLE SOURCE OF PROBLEM
NO COMMUNICATION	 Transmitter Connections Check wiring polarity and continuity. Check for shorts or ground loops. Check if the power supply connector is connected to main board. Check if the shield is not used as a conductor. It should be grounded at one end only. Power Supply Check power supply output. The voltage must be between 9 - 32 VDC at the DT302 terminals. Noise and ripple should be within the following limits: a) 16 mV peak to peak from 7.8 to 39 KHz. b) 2 V peak to peak from 47 to 63 Hz for non-intrinsic safety applications and 0.2 V for intrinsic safety application. c) 1.6 V peak to peak from 3.9 MHz to 125 MHz. Network Connection Check that the topology is correct and all devices are connected in parallel. Check that two Terminators are OK and correctly positioned. Check that the Terminators are according to the specifications. Check length of trunk and spurs. Check spacing between couplers. Network Configuration Check the network communication configuration. Electronic Circuit Failure Check the main board for defect by replacing it with a spare one.
INCORRECT READING	Transmitter Connections Check for intermittent short circuits, open circuits and grounding problems. Check if the sensor is correctly connected to the DT302 terminal block. Noise, Oscillation Adjust damping. Check grounding of the transmitters housing. Check that the shielding of the wires between transmitter / panel is grounded only in one end. Sensor Check the sensor operation; it shall be within its characteristics. Check sensor type; it shall be the type and standard that the DT302 has been configured to. Check if process is within the range of the sensor and the DT302.

Table 4.1 - Symptoms and Probable Source of Problem

If the problem is not presented in the table above follow the Note below:

NOTE

The Factory Init should be tried as a last option to recover the equipment control when the equipment presents some problem related to the function blocks or the communication. This operation must only be carried out by authorized technical personnel and with the process offline, since the equipment will be configured with standard and factory data.

This procedure resets all the configurations run on the equipment, after which a partial download should be performed.

Two magnetic tools should be used to this effect. On the equipment, withdraw the nut that fixes the identification tag on the top of the housing, so that access is gained to the "S" and "Z" holes.

The operations to follow are:

- Switch off the equipment, insert the magnetic tools and keep them in the holes (the magnetic end in the holes):
- 2) Feed the equipment;
- 3) As soon as Factory Init is shown on the display, take off the tools and wait for the "S" symbol on the right upper corner of the display to unlit, thus indicating the end of the operation.

This procedure makes effective the entire factory configuration and will eliminate eventual problems with the function blocks or with the equipment communication.

Procedure to change the DT302 Main Board

- Replace the GLL852 main board 1.0X to 2.0X. version
- Read from sensor (Backup menu).
- Trim the temperature with two temperatures 30°C apart.
- This procedure must be done, when the temperature is steady, a temperature standard must be used as a reference to adjust the DT temperature.
- After the temperature trim, make the self-calibration.

Disassembly Procedure

WARNING

Do not disassemble with power on.

Figures 4.3 and 4.4 show transmitter's exploded view and will help you to understand the text below. The numbers between parentheses are relating to the enumeration of the items of the related drawing.

Group of the Probe (16A, 16B, 19A or 19B)

To have access to the probe for cleaning, it is necessary to remove it from the process. Remove the transmitter loosening the against-flange.

Cleaning should be done carefully in order to avoid damaging of the delicate isolating diaphragms. Use of a soft cloth and a nonacid solution is recommended.

To remove the sensor from the electronic housing, the electrical connections (in the field terminal side) and the main board connector must be disconnected.

Loosen the hex screw (6) and carefully unscrew the electronic housing from the sensor, observing that the flat cable is not excessively twisted.

WARNING

To avoid damage do not rotate the electronic housing more than 270° starting from the fully threaded without disconnecting the electronic circuit from the sensor and from the power supply. See Figure 4.1.



Figure 4.1 - Safe Housing Rotation

Electronic Circuit

To remove the circuit board (5), loosen the two screws (3) that anchor the board.

WARNING

The board has CMOS components, which may be damaged by electrostatic discharges. Observe correct procedures for handling CMOS components. It is also recommended to store the circuit boards in electrostatic-proof cases.

Pull the main board out of the housing and disconnect the power supply and the sensor connectors.

Reassemble Procedure

WARNING

Do not assemble the main board with power on.

Group of the Probe (16A, 16B, 19A or 19B)

The bolts, nuts, flanges and other parts should be inspected for corrosion or other eventual damage. Damaged parts should be replaced.

The fitting of the sensor must be done with the main board out of the electronic housing. Mount the sensor to the housing turning clockwise until it stops. Then turn it counterclockwise until it faces the protective cover (1) parallel to the process flange. Tighten the hex screw (6) to lock the housing to the sensor. Only after that is recommended to install the main board.

Electronic Circuit

Plug sensor connector and power supply connector to main board. Attach the display to the main board. Observe the four possible mounting positions. The Smar mark indicates up position.

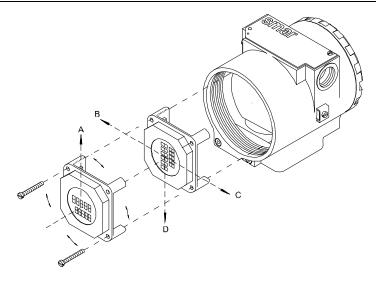


Figure 4.2 - Four Possible Positions for Display

Anchor the main board and display with their screws (3).

After tightening the protective cover (1), mounting procedure is complete. The transmitter is ready to be energized and tested.

Interchangeability

In order to obtain an accurate and better temperature compensated response. Each sensor is submitted to a factory characterization process and the specific data is stored in an EEPROM located in the sensor body.

Every time the power is turned on, the main circuit reads the sensor serial number, should it differ from the number stored in the memory. The circuit understands that there is a new sensor and the following information is transferred from the sensor to the main circuit.

- Temperature compensation coefficients.
- Sensor's trim, including 5-point characterization curve.
- Sensor characteristics: type, range, diaphragm material and fill fluid.

The other transmitter characteristics are stored in the main circuit memory and are not affected by sensor change.

Data transfer from the sensor to the main circuit can also be forced by parameter BACKUP_RESTORE previously explained. In case of changing of the main board, the information of the sensor, as described above are up-to-date.

Upgrading DT301 to DT302

The sensor and casing of the DT301 is exactly the same as the **DT302**. By changing the circuit board of the DT301 it becomes a **DT302**.

Upgrading the DT301 to a **DT302** is therefore very much the same as the procedure for replacing the main board described above.

To remove the circuit board **(5)**, loosen the two screws (3) that anchor the board. Caution with the circuit boards must be taken as mentioned above. Pull the DT301 main board out of the housing and disconnect the power supply and the sensor connectors.

Put in the DT302 main board reversing the procedure for removing the DT301 circuit.

Returning Materials

If it becomes necessary to return the transmitter and/or configurator to Smar, simply contact our office, informing the defective instrument's serial number, and return it to our factory. In order to speed up analysis and solution of the problem, the defective item should be returned with the Service Request Form (SRF – Appendix B) properly filled with a description of the failure observed and with as much details as possible. Other information concerning to the instrument operation, such as service and process conditions, is also helpful.

ACCESSORIES					
ORDERING CODE	DESCRIPTION				
SD1	Magnetic Tool for Local Adjustment				
BC1	Fieldbus/RS232 Interface				
PS302	Power Supply				
FDI302	Field Device Interface				
BT302	Terminator				
DF47	Intrinsic Safety Barrier				
DF48	Fieldbus Repeater				

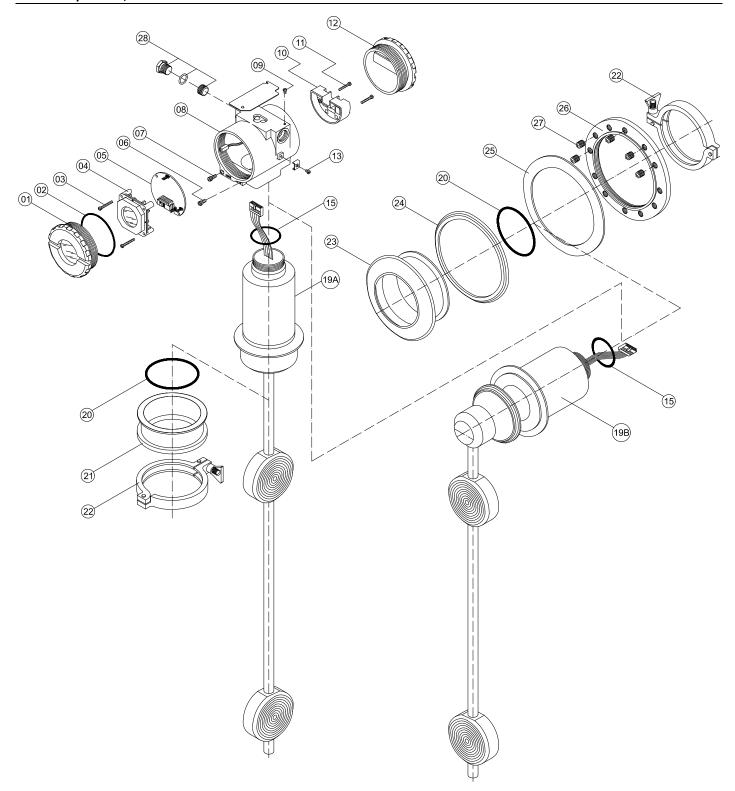


Figure 4.3 - DT302 Exploded View - Sanitary Model

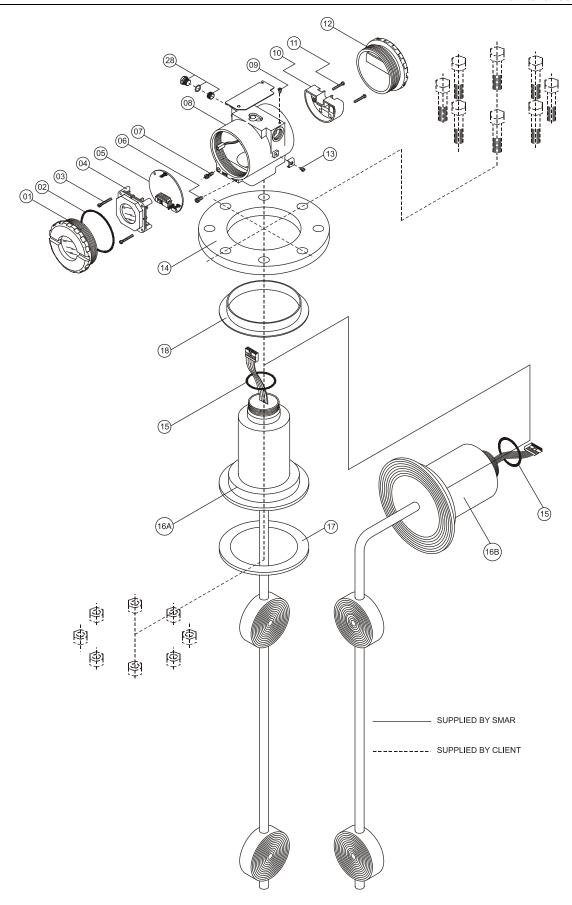


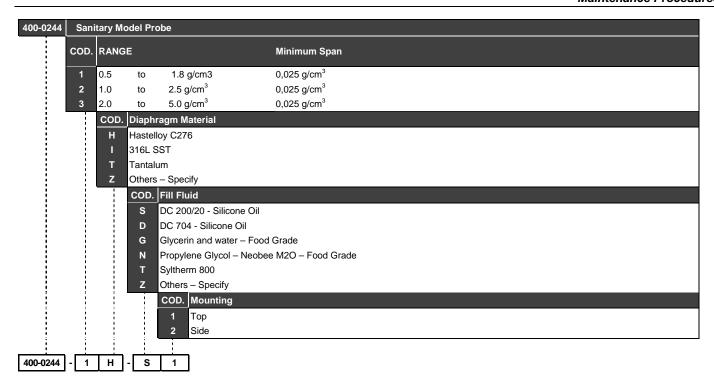
Figure 4.4 - DT302 Exploded View - Industrial Model

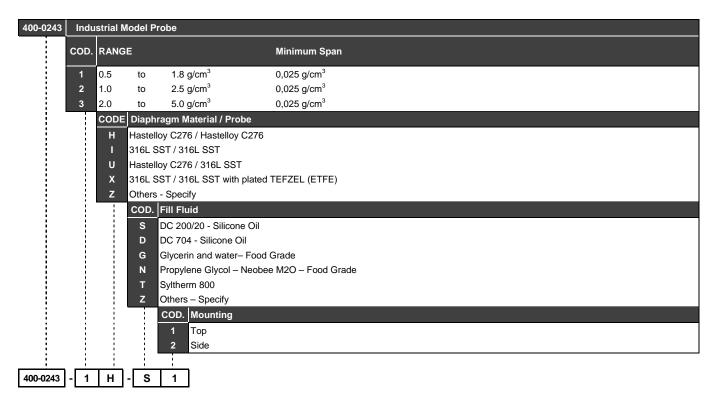
SPARE PARTS LIST					
DESCRIPTION OF PARTS	POSITION	CODE	CATEGORY (NOTE 1)		
HOUSING, Aluminum (NOTE 2)					
½ - 14 NPT	8	400-0252			
M20 x 1.5	8	400-0253			
PG 13.5 DIN	8	400-0254			
HOUSING, 316 SS (NOTE 2)					
½ - 14 NPT	8	400-0255			
M20 x 1.5	8	400-0256			
PG 13.5 DIN	8	400-0257			
COVER (INCLUDES O-RING)	1 110	201.0100			
Aluminum	1 and 12	204-0102	_		
316 SS COVER WITH WINDOW FOR INDICATION (INCLUDES O-RING)	1 and 12	204-0105			
Aluminum	1	204-0103	1		
316 SS	1	204-0103			
COVER LOCKING SCREW	7	204-0100	+		
SENSOR LOCKING SCREW	1	204-0120	+		
Without head M6 screw	6	400-1121			
EXTERNAL GROUND SCREW	13	204-0124			
IDENTIFICATION PLATE FIXING SCREW	9	204-0124	+		
DIGITAL INDICATOR	4	214-0108	+		
TERMINAL INSULATOR	10	314-0123			
MAIN ELECTRONIC CIRCUIT BOARD (NOTE 3)	5	400-0245	A		
O-RINGS (NOTE 4)	<u> </u>	400-0243	Λ		
Cover, Buna-N	2	204-0122	В		
Neck, Buna-N	15	204-0113	В		
Process connection, Buna-N (Sanitary Model)	20	400-0236	В		
Process connection, Viton (Sanitary Model)	20	400-0813	B		
Process connection, Teflon (Sanitary Model)	20	400-0814	В		
TERMINAL HOLDING SCREW.		.00 00			
Housing in Aluminum	11	304-0119			
Housing in 316 Stainless Steel	11	204-0119			
MAIN BOARD SCREW HOUSING IN ALUMINUM		•	•		
Units with indicator	3	304-0118			
Units without indicator	3	304-0117			
MAIN BOARD SCREW HOUSING IN 316 STAINLESS STEEL			·		
Units with indicator	3	204-0118			
Units without indicator	3	204-0117			
PROCESS CONECTION – INDUSTRIAL MODEL					
Flange 4" – 150# ANSI B-16.5, 316 SST	14	400-0237			
Flange 4" – 300# ANSI B-16.5, 316 SST	14	400-0238			
Flange 4" – 600# ANSI B-16.5, 316 SST	14	400-0239			
Flange DN 100, PN 25 / 40, DIN 2526 – Form D, 316 SST	14	400-0240			
Teflon Closing Junction	17	400-0720			
Teflon Insulation Junction	18	400-0863	1		
PROCESS CONNECTION - SANITARY MODEL					
Tank Adapter for Straight Model 316 SST	21	400-0241			
Tri-Clamp de 4", 304 SST	22	400-0242			
Tank Adapter for Curve Model 316 SST	23	400-0721	_		
Silicon Closing Ring	24	400-0722			
Protection Flange	25	400-0723	1		
Tightening Flange Server	26	400-0724 400-0725	1		
Tightening Flange Screw 1/2" NPT Internal Socket set Plug in Bichromatized Carbon Steel BR-EX D	27	400-0725			
1/2" NPT Internal Socket set Plug in Bichromatized Carbon Steel BR-EX D 1/2" NPT Internal Socket set Plug in 304 SST BR-EX D	28 28	400-0808			
M20 X 1.5 External Socket set Plug in 316 SST BR-EX D	28	400-0809			
PG13.5 External Socket set Plug in 316 SST BR-EX D	28	400-0810			
3/4 NPT Adapter in 316 SST BR-EX D	28	400-0811			
PROBE		100 0012	1		
Industrial Probe	16A or 16B	(NOTE 5)	В		
Sanitary Probe	19A or 19B	(NOTE 5)	В		
		()			

Table 4.2 - Spare Parts List

- **NOTE 1:** For category A, it is recommended to keep, in stock, 25 parts installed for each set, and for category B, 50. **NOTE 2:** Includes Terminal Block, Bolts, caps and Identification plate without certification. **NOTE 3:** The main board of **DT302** and probe are items.

- NOTE 4: O-rings are packaged in packs of 12 units.
 NOTE 5: To specify sensors, use the following tables.





TECHNICAL CHARACTERISTICS

Filling Fluids

The filling fluid selection shall take into account its physical properties in what concerns to pressure temperature limits and chemical compatibility with the process fluid. The latter is an important consideration in case the filling fluid happens to come in contact with the process fluid, should a leakage occur.

Table 5.1 presents the filling fluids, which are available for the **DT302**, together with physical properties and applications.

FILLING FLUID	VISCOSITY (cSt) at 25°C	DENSITY (g/cm³ at 25ºC)	THERMAL EXPANSION COEFICIENT (1/°C)	APPLICATIONS	
Silicone DC 200/20	20	0.95	0.00107	General purpose – Standard	
Silicone DC 704	39	1.07	0.000799	General purpose – (high temperature and vacuum)	
Sytherm 800	10	0.934	0.0009	General Purpose (extreme temperatures, positive and negative)	
Propylene Glycol (Neobee M20) Food Grade	9.8	0.90	0.001	Beverage and pharmaceutical food grade	
Glycerin and Water Food Grade	12.5	1.13	0.00034	Food grade	

Table 5.1 - Properties of Filling Fluids

Functional Specifications

Output Signal

Digital, only. Foundation[™] Fieldbus, 31.25 kbit/s, voltage mode with bus power.

Power Supply

Bus powered: 9 - 32 Vdc.

Quiescent current consumption: 12 mA.

Indicator

4 ½ -digit numerical and 5-character alphanumerical LCD indicator.

Hazardous Area Certifications

Explosion, weather and intrinsically safe proof. Certified by CEPEL, FM, Dekra/EXAM and NEMKO.

Other Certification

3A standard.

Temperature Limits

Ambient: -40 to 85° C (-40 to 185° F)
Process: -20 to 150° C (-04 to 302° F)
Storage: -40 to 100° C (-40 to 212° F)
Digital Display: -10 to 60° C (14 to 140° F)

Static Pressure Limit

70 kgf/cm² (7 MPa) (1015 PSI).

Turn-on Time

Approximately 5 seconds.

Volumetric Displacement

Less than 0.15 cm³ (0.01 in³)

Humidity Limits

0 to 100% RH.

Temperature Compensation

Automatic with PT100.

Performance Specifications

Reference conditions: temperature 25°C (77°F), power supply of 24 Vdc, normal atmospheric pressure, silicone oil fill and range full - scale calibration.

RANGE	ACCURACY (1)	AMBIENT TEMPERATURE EFFECT / 10°C	STABILITY (For 3 Months)	STATIC PRESSURE EFFECT (2) (per 1 kgf/cm²)
1	±0.0004 g/cm ³ (±0.1 °Brix)	0.003 kg/m ³	0.021 kg/m ³	0.001 kg/m³
2	±0.0007 g/cm ³	0.013 kg/m ³	0.083 kg/m ³	0.004 kg/m ³
3	±0.0016 g/cm ³	0.041 kg/m ³	0.521 kg/m ³	0.007 kg/m ³

- (1) Linearity, hysteresis and repeatability effects are included.
- (2) This is systematic error that can be eliminated by calibrating at the operating static pressure.

Table 5.2 - Performance Specifications

Power Supply Effect

±0.005 of calibrated FS per volt.

Electro-Magnetic Interference Effect

Designed to comply with IEC 61326-1:2006, IEC 61326-2-3:2006, IEC 61000-6-4:2006 and IEC 61000-6-2:2005.

Physical Specifications

Electrical Connection

1/2 -14 NPT, Pg 13.5 or M20 x 1.5".

Process Connection

Industrial model: 316 SST flange ANSI B16.5, Flange DIN 2526 Form D, DN100 PN 25/40. Sanitary model: 304 SST Tri-clamp.

Wetted Parts

Isolating diaphragms: 316L SST or Hastelloy C276. Probe material: 316L SST or Hastelloy C276 O-ring for sanitary model: Buna-N, VitonTM or TeflonTM

Non-wetted Parts

Electronic Housing: injected low copper aluminum with polyester painting or 316 SST housing, with Buna-N o-rings on cover (NEMA 4X, IP67).

Fill fluid: Silicone (DC200/20, DC704), Syltherm 800, Glycerin and Water or Neobee M20 Propylene Glycol.

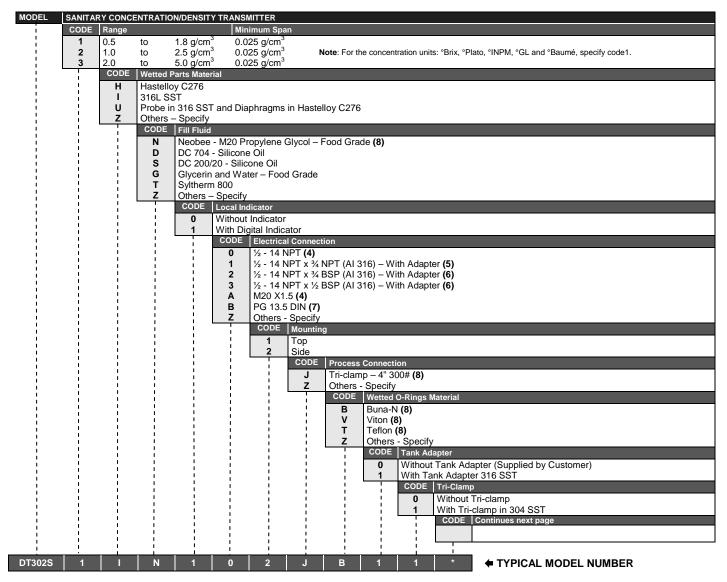
Identification plate: 316 SST.

Mounting

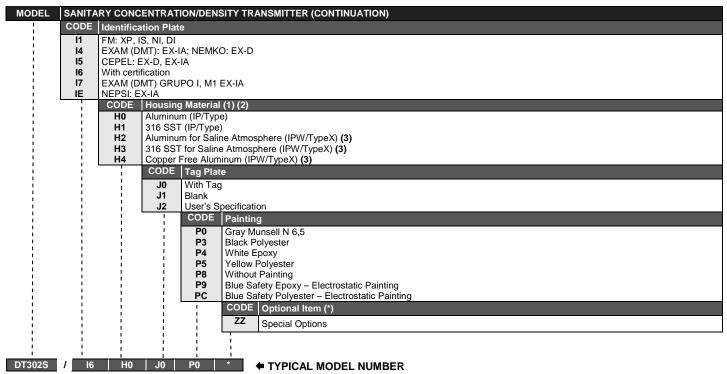
Side or top mounting.

Sanitary model: 9 kg (20 lb) - Industrial model: 14 kg (31 lb).

Ordering Code



^{*} Leave it blank for no optional items.



^{*} Leave it blank for no optional items.

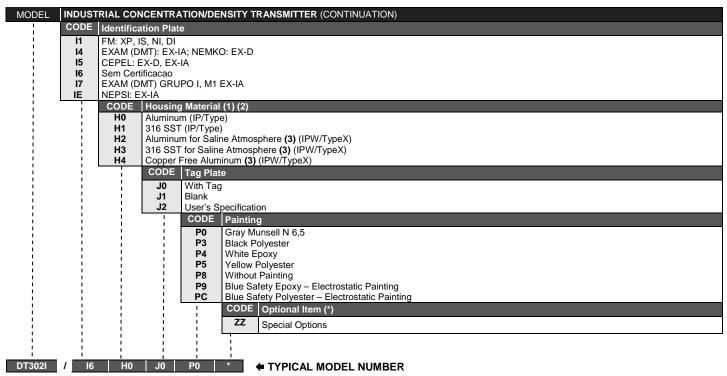
- (1) IPX8 tested in 10 meters of water column for 24 hours.
- (2) Ingress Protection:

Produ	ıct C	EPEL NEMK(* : I FM	CSA	NEPSI
DT30	X IP6	6/68/W IP66/68	/W Type 4X	/6 Type 4X	IP67

- (3) IPW / TypeX tested for 200 hours according to NBR 8094 / ASTM B 117 standard.(4) Certified for use in Explosive Atmosphere (CEPEL, FM, NEPSI, NEMKO and EXAM).
- Certified for use in Explosive Atmosphere (CEPEL and FM).
- (6) Options not certified for Explosive Atmosphere.
- Certified for use in Explosive Atmosphere (CEPEL, NEPSI, NEMKO and EXAM).
- Compliant with 3A-7403 standard for food and other applications where sanitary connections are required.
 - Neobee M2O Fill Fluid
 - Finishing wet Face: 0.8 μm Ra (32 μ" AA)
 - Wet O-Ring: Viton, Teflon and Buna-N

MODEL	INDUST	TRIAL CO	NCENTR	ATION/E	ENSITY	TRANSMITTE	ER CONTROL OF THE CON					
INODEL		TRIAL CONCENTRATION/DENSI				Minimum Span						
-	1	0.5 to 1.8 g/cm ³				0.025 g/cm ³						
!	2		2.5 q/c			0.025 g/cm ³	Note : For the concentration units: "Brix, "Plato, "INPM, "GL and "Baumé, specify code1.					
i	3		5.0 g/c			0.025 g/cm ³	The state of the content and an arrange and arrange and arrange opening code in					
	-		Diaphrag									
!	i	Н	Hastelloy									
i	 	1	316L SST									
	!	U	Hastelloy	C276/	316L SS	Т						
!	i				SST with	rith plated TEFZEL (ETFE)						
i	!	Z	Others - S									
1	!	i	CODE									
!	i						- Food Grade					
i		!			- Silicon							
- 1	!	i			20 - Silic							
!	į	1		Syltherm		ter – Food Gra	de					
i	-	!			Specify							
:	1	i '				ndicator						
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į	i		- 1	-	1		⁷ / ₄ NPT (AI 316) – With Adapter (5)					
i	!			!	2		3/4 BSP (AI 316) – With Adapter (6)					
-	!	i	i	i	3		½ BSP (AI 316) – With Adapter (6)					
!	i		:	-	Α	M20 X1.5 (4)						
i	-	į	į	- !	В	PG 13.5 DIN						
1	!	i	i	i	Z	Others - Spec						
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į	i	-	1	1	i i		Between Centre of the Sensors 250 mm					
i	1	į	<u> </u>	!	-		DE Process Connection Size, Rating and Standard					
- 1		i	i	i	- 1		1 4" 150# ANSI B – 16.5					
!	i	-	-	-	į	5	2 4" 300# ANSI B – 16.5					
i	-		į	1	i	5	3 4" 600# ANSI B – 16.5					
:	1	i	i	į	1	A	C DN 100 PN25/40 DIN 2526 – FORM D					
!	į	!	1	-	į	Z	Z Others – Specify					
i		!	!	-	i		CODE Continues next page					
	!	į	į	į	1	i i						
1	į	:		i	1	-						
DTagg			-	1	:		4 TYPICAL MODEL NUMBER					
DT302I	1		S	1	0	1 5	1 * TYPICAL MODEL NUMBER					

^{*} Leave it blank for no optional items.



^{*} Leave it blank for no optional items.

Optional Items

Diaphragm Thickness	N0 - Standard					
Diaphragin Thickness	N1 – 0.1 mm					
Strengthening of the Probe	R1 – with strengthening of the probe					
Mounting Position	E1 – reverse position					

(1) IPX8 tested in 10 meters of water column for 24 hours. (2) Ingress Protection: NEMKO/ Product **CEPEL** FΜ CSA **NEPSI EXAM** DT30X IP66/68/W IP66/68/W Type 4X/6 Type 4X IP67

- (3) IPW / TypeX tested for 200 hours according to NBR 8094 / ASTM B 117 standard.
- (4) Certified for use in Explosive Atmosphere (CEPEL, FM, NEPSI, NEMKO and EXAM).
- Certified for use in Explosive Atmosphere (CEPEL and FM).
- (6) Options not certified for Explosive Atmosphere.
- (7) Certified for use in Explosive Atmosphere (CEPEL, NEPSI, NEMKO and EXAM).

CERTIFICATIONS INFORMATION

European Directive Information

Consult www.smar.com for the EC declarations of conformity for all applicable European directives and certificates.

ATEX Directive (94/9/EC) – "Electrical equipment and protective system intended for use in potential explosive atmospheres"

The EC-Type Examination Certificate had been released by Nemko AS (CE0470) and/or DEKRA EXAM GmbH (CE0158), according to European Standards.

The certification body for Production Quality Assurance Notification (QAN) and IECEx Quality Assessment Report (QAR) is Nemko AS (CE0470).

LVD Directive 2006/95/EC – "Electrical Equipment designed for use within certain voltage limits"

According the LVD directive Annex II, electrical equipment for use in an explosive atmosphere is outside the scope of this directive.

According to IEC standard: IEC 61010-1:2010 - Safety requirements for electrical equipment for measurement, control, and laboratory use - Part 1: General requirements.

Other Approvals

Device Registration ITK:

Fieldbus Foundation

Model: DT302

Device Type: Density Transmitter

ITK Ver: 4.6

ITK Campaign No.: IT031100 Registration Date: 3/2/2005

DD Revision: 0x01

CFF Revision: 070101.CFF

The above device has successfully completed rigorous testing by the Fieldbus Foundation and has received registration and the right to use the FF checkmark logo as specified by MT-045.

Hazardous Locations General Information

Ex Standards:

IEC 60079-0 General Requirements

IEC 60079-1 Flameproof Enclosures "d"

IEC 60079-11 Intrinsic Safety "i"

IEC 60079-26 Equipment with equipment protection level (EPL) Ga

IEC 60529 Classification of degrees of protection provided by enclosures (IP Code)

Customer responsibility:

IEC 60079-10 Classification of Hazardous Areas

IEC 60079-14 Electrical installation design, selection and erection

IEC 60079-17 Electrical Installations, Inspections and Maintenance

Warning:

Explosions could result in death or serious injury, besides financial damage.

Installation of this instrument in an explosive environment must be in accordance with the national standards and according to the local environmental protection method. Before proceeding with the installation match the certificate parameters according to the environmental classification.

General Notes:

Maintenance and Repair

The instrument modification or replaced parts supplied by any other supplier than authorized representative of Smar Equipamentos Industriais Ltda is prohibited and will void the Certification.

Marking Label

Once a device labeled with multiple approval types is installed, do not reinstall it using any other approval types. Scratch off or mark unused approval types on the approval label.

For Ex-i protection application

- Connect the instrument to a proper intrinsically safe barrier.
- Check the intrinsically safe parameters involving the barrier, equipment including the cable and connections.
- Associated apparatus ground bus shall be insulated from panels and mounting enclosures.
- When using shielded cable, isolate the not grounded cable end.
- Cable capacitance and inductance plus C_i and L_i must be smaller than C_o and L_o of the Associated Apparatus.

For Ex-d protection application

- Only use Explosion Proof/Flameproof certified Plugs, Adapters and Cable glands.
- In an Explosion-Proof/Flame-Proof installation, do not remove the instrument housing covers when powered on.

- Electrical Connection

In Explosion-Proof installations the cable entries must be connected through conduit with sealed unit or closed using metal cable gland or closed using metal blanking plug, all with at least IP66 and Ex-d certification. For enclosure with saline environment protection (W) and ingress protection (IP) applications, all NPT thread parts must apply a proper water-proof sealant (a non-hardening silicone group sealant is recommended).

For Ex-d and Ex-i protection application

- The transmitter has a double protection. In this case the transmitter shall be fitted with appropriate certified cable entries Ex-d and the electric circuit supplied by a certified diode safety barrier as specified for the protection Ex-ia.

Environmental Protection

- Enclosure Types (Type X): Supplementary letter X meaning special condition defined as default by Smar the following: Saline Environment approved salt spray exposed for 200 hours at 35°C. (Ref: NEMA 250).
- Ingress protection (IP W): Supplementary letter W meaning special condition defined as default by Smar the following: Saline Environment approved salt spray exposed for 200 hours at 35°C. (Ref: IEC60529).
- Ingress protection (IP x8): Second numeral meaning continuous immersion in water under special condition defined as default by Smar the following: 1 Bar pressure during 24hours. (Ref: IEC60529).

Hazardous Locations Certifications

North American Certifications

FM Approvals (Factory Mutual)

Intrinsic Safety (FM 3015610)

IS Class I, Division 1, Groups A, B, C and D IS Class II, Division 1, Groups E, F and G IS Class III, Division 1

Explosion Proof (FM 3015610)

XP Class I, Division 1, Groups A, B, C and D

Dust Ignition Proof (FM 3015610)

DIP Class II, Division 1, Groups E, F and G DIP Class III. Division 1

Non Incendive (FM 3015610)

NI Class I, Division 2, Groups A, B, C and D

Environmental Protection (FM 3015610)

Option: Type 4X/6 or Type 4/6

Special conditions for safe use:

Entity Parameters: Fieldbus Power Supply Input (report 3015629):

Vmax = 24 Vdc, Imax = 250 mA, Pi = 1.2 W, Ci = 5 nF, Li = 8 uH

Vmax = 16 Vdc, Imax = 250 mA, Pi = 2.0 W, Ci = 5 nF, Li = 8 uH

Temperature Class: T4

Maximum Ambient Temperature: 60°C (-20 to 60 °C) Overpressure Limits: 1015 psi (report 3011728)

European Certifications

NEMKO Approval

Explosion Proof (Nemko 03ATEX1375X)

Group II, Category 2 G, Ex d, Group IIC, Temperature Class T6, EPL Gb

Ambient Temperature: -20 °C to +60 °C

Environmental Protection (Nemko 03ATEX1375X)

Options: IP66/68W or IP66/68

Special conditions for safe use:

Repairs of the flameproof joints must be made in compliance with the structural specifications provided by the manufacturer.

Repairs must not be made on the basis of values specified in tables 1 and 2 of EN/IEC 60079-1.

The Essential Health and Safety Requirements are assured by compliance with:

EN 60079-0:2012 General Requirements

EN 60079-1:2007 Flameproof Enclosures "d"

EXAM Approval (BBG Prüf - und Zertifizier GmbH)

Intrinsic Safety (DMT 03 ATEX E 359)

Group I, Category M1, Ex ia, Group I, EPL MA

Group II, Category 1/2 G, Ex ia, Group IIC, Temperature Class T4/T5/T6, EPL Ga/Gb

FISCO Field Device

Supply circuit for the connection to an intrinsically safe fieldbus circuit:

Ui = 24 Vdc, Ii = 380 mA, Pi = 5.32 W, Ci ≤ 5 nF, Li = Neg

Parameters of the supply circuit comply with FISCO model according to Annex G EN 60079-11:2012, replacing EN 60079-27: 2008.

Ambient Temperature: -40°C ≤ Ta ≤ +60°C

The Essential Health and Safety Requirements are assured by compliance with:

EN 60079-0:2009 + A11:2013 General Requirements

EN 60079-11:2012 Intrinsic Safety "i"

EN 60079-26:2015 Equipment with equipment protection level (EPL) Ga

South American Certifications

INMETRO Approvals

Intrinsic Safety (CEPEL 02.0125X)

Ex ia, Group IIC, Temperature Class T4/T5, EPL Ga

FISCO Field Device

Entity Parameters:

Pi = 5.32 W Ui = 30 V Ii = 380 mA Ci = 5.0 nF Li = Neg

Ambient Temperature: -20 to 65 °C for T4

-20 to 50 °C for T5

Explosion Proof (CEPEL 02.0126)

Ex d, Group IIC, Temperature Class T6, EPL Gb

Ambient Temperature: 40 °C (-20 a 40 °C)

Environmental Protection (CEPEL 02.0125X and CEPEL 02.0126)

Options: IP 66/68 W or IP 66/68

Special conditions for safe use:

The certificate number ends with the letter "X" to indicate that for the version of Density Transmitter model DT302 equipped with housing made of aluminum alloy, only can be installed in "Zone 0" if is excluded the risk of occurs impact or friction between the housing and iron/steel itens.

The Essential Health and Safety Requirements are assured by compliance with:

ABNT NBR IEC 60079-0:2008 General Requirements

ABNT NBR IEC 60079-1:2009 Flameproof Enclosures "d"

ABNT NBR IEC 60079-11:2009 Intrinsic Safety "i"

ABNT NBR IEC 60079-26:2008 Equipment with equipment protection level (EPL) Ga

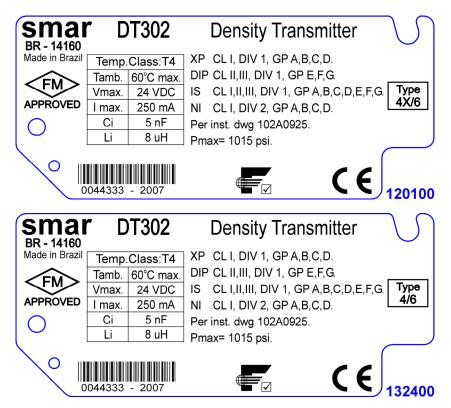
IEC 60079-27:2008 Fieldbus intrinsically safe concept (FISCO)

ABNT NBR IEC 60529:2009 Classification of degrees of protection provided by enclosures (IP Code)

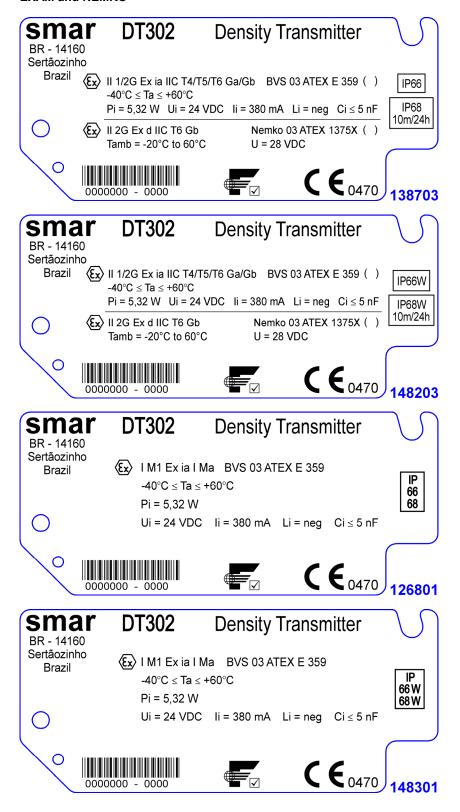
Identification Plate and Control Drawing

Identification Plate

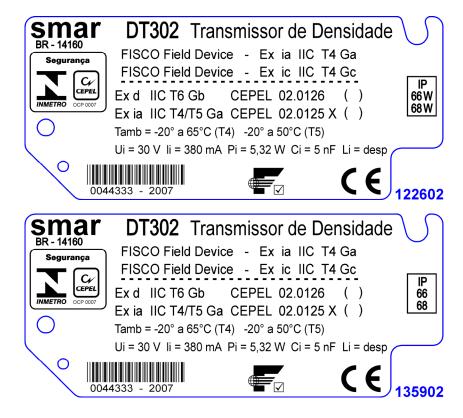
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EXAM and NEMKO

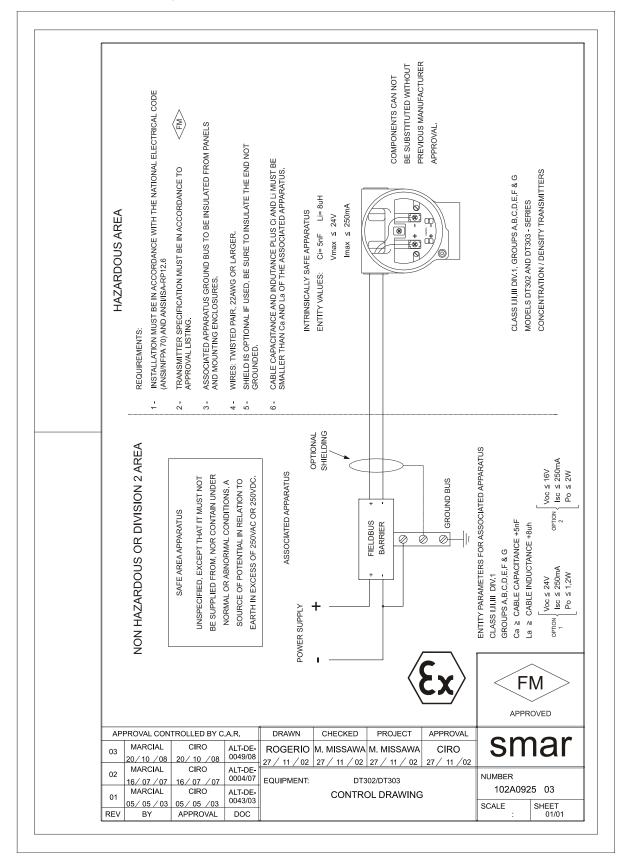


CEPEL



Control Drawing

Factory Mutual (FM)



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Company:			Invoice:								
Full Name:	COMMERC	IAL CONTACT	Full Name	TECHNICAL CONTACT Full Name:							
Function:											
Phone:		Ext	Phone: Extension:								
Fax:			Fax:								
Email:			Email:								
Model:			ATA Number: Sensor Number:								
Technology: () HA	RT®	() Foundation	fieldbus™	() PROFIBL	JS PA	Firmware Version:				
PROCESS DATA											
Process Fluid:											
Calibration	Range	Ambient Tem	perature (°F)	Р	rocess Temperature (°F)		Process Pressure				
Min.:	Max.:	Min.:	Мах.:	Min.:		Max.:	Min.:	Max.:			
Static Pres	ssure	Vacuum				nsity	Cond	entration			
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Normal Operation Tir	ne:	1		Fai	lure Date:	<u> </u>	<u>. I</u>	l			
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(Please, describe the observed behavior, if it is repetitive, how it reproduces, etc.)											
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